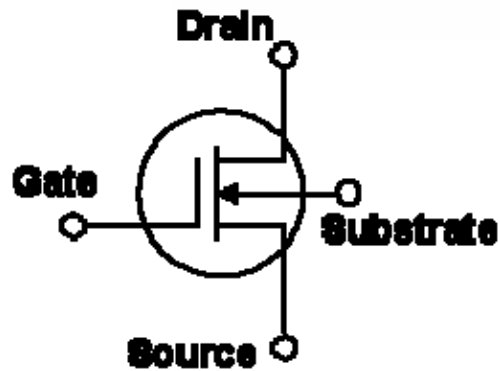
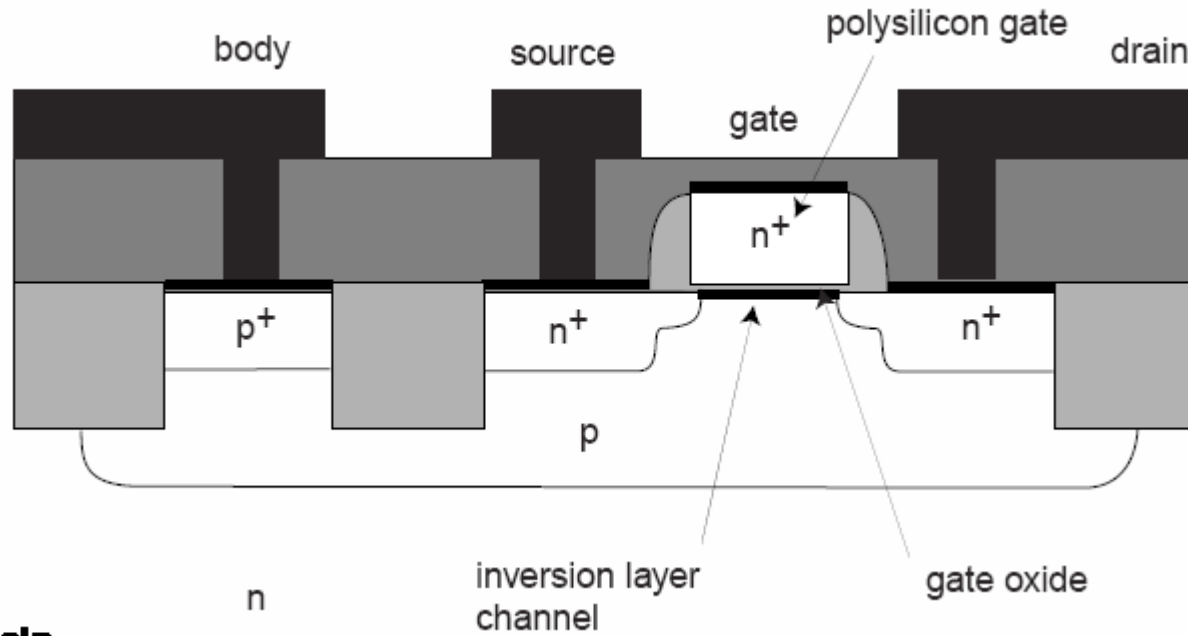


10. MOSFETs

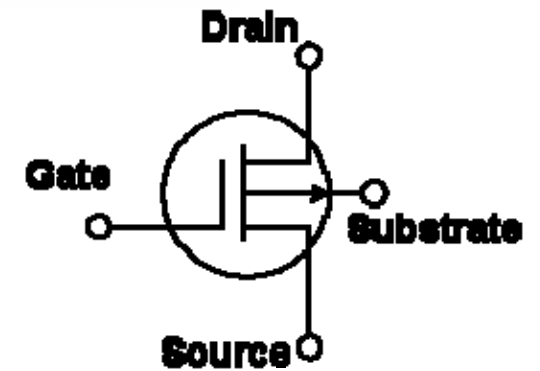
Dec. 4, 2019

MOSFETs



n - channel

functions as a switch
 ~ 1 billion /chip



p - channel

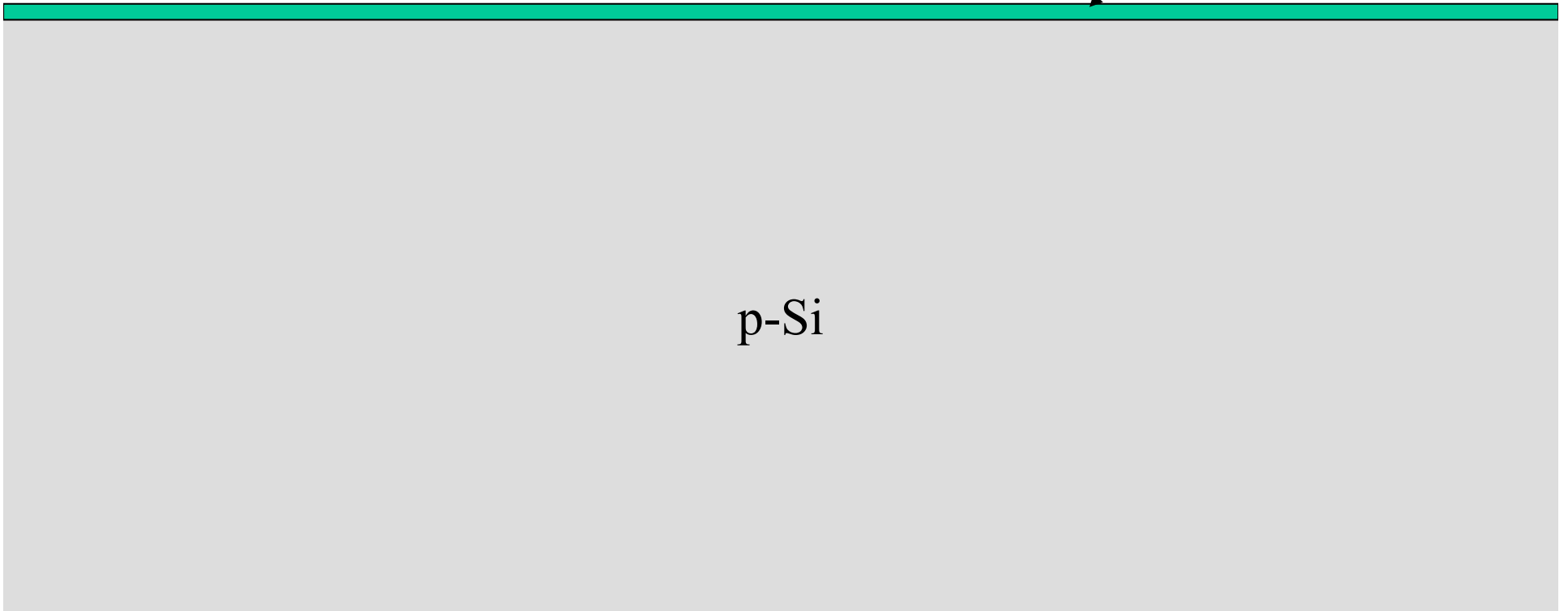
Self-aligned fabrication

p-Si 100 wafer

Dry oxidation

SiO₂ gate oxide

p-Si

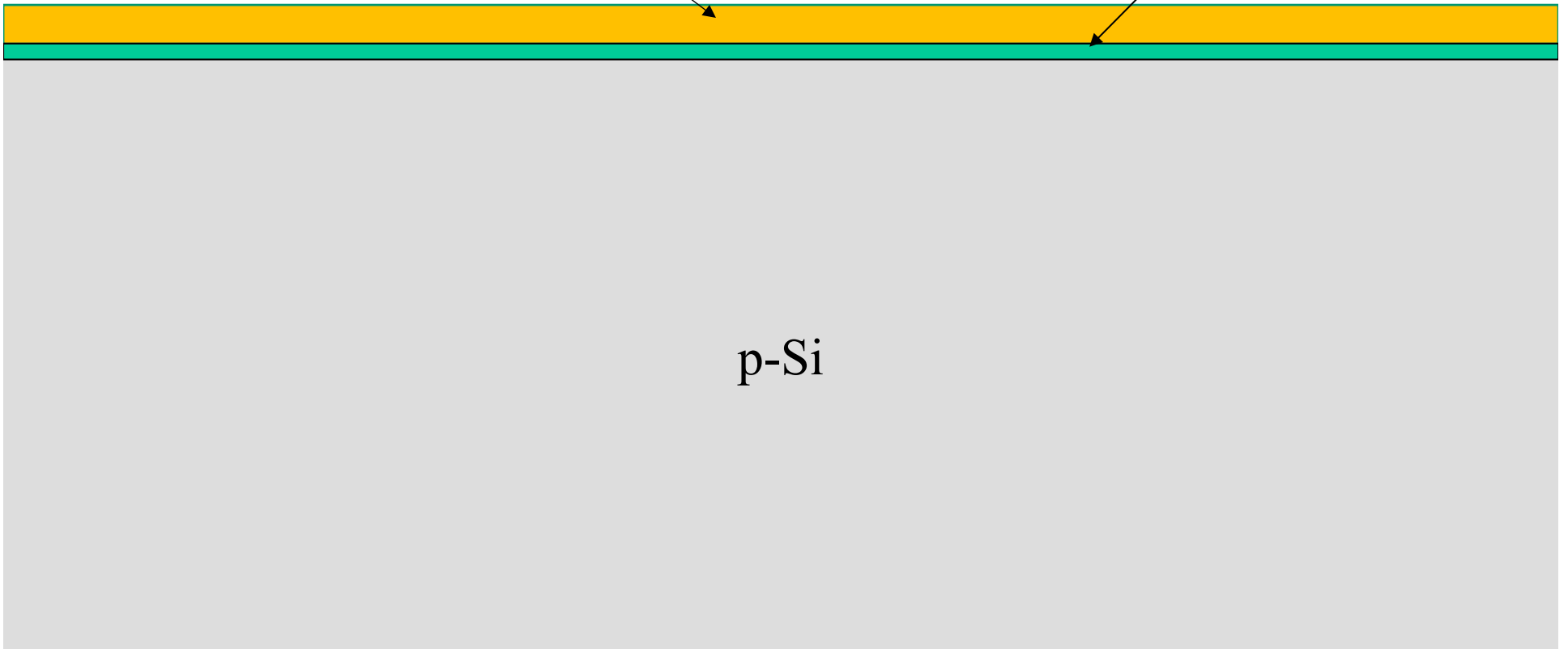


gate oxide

HfO₂

SiO₂

p-Si



photoresist

polysilicon

CVD: SiH_4 @ 580 to 650 °C

$\text{SiO}_2/\text{HfO}_2$

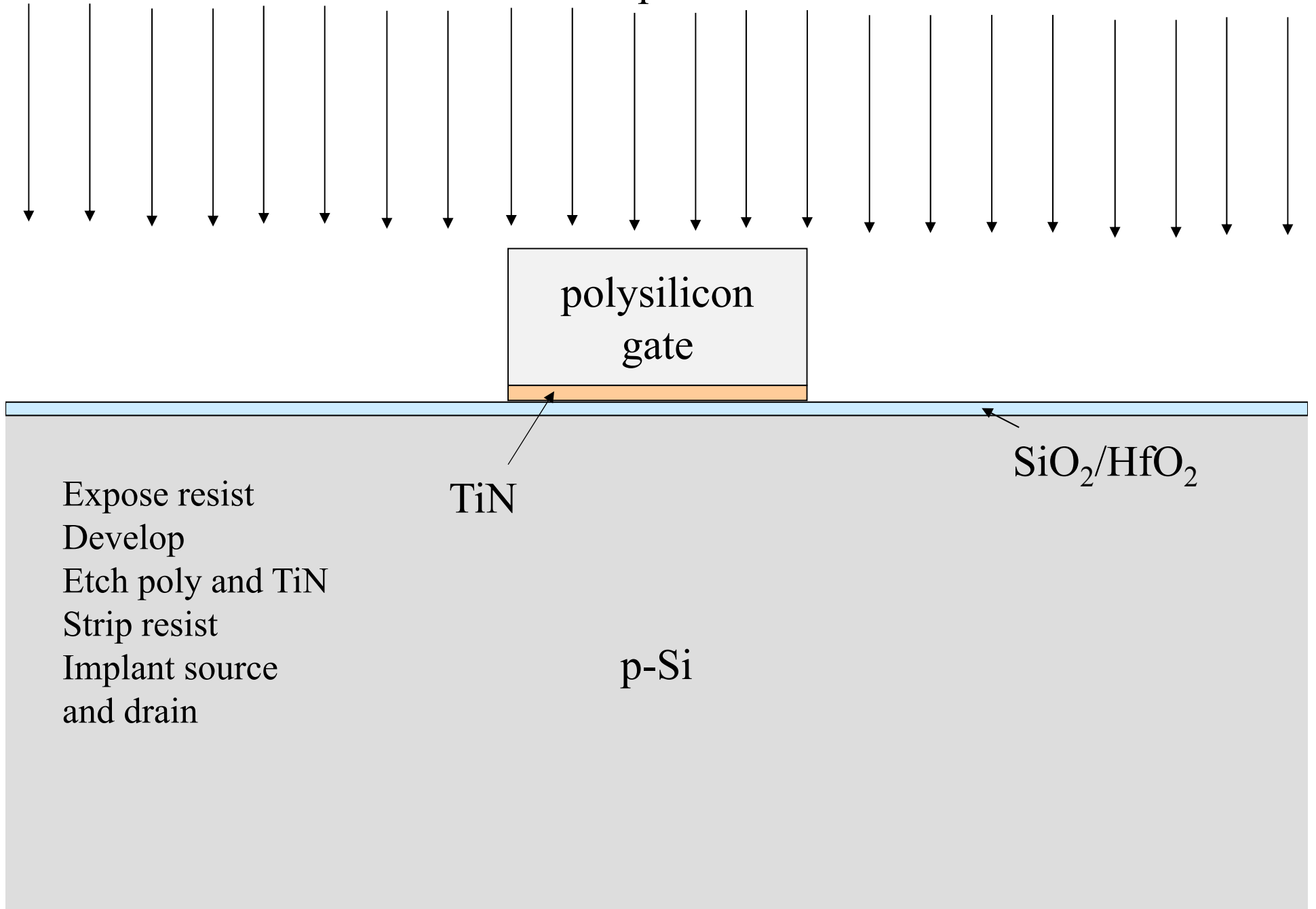
TiN (CVD)

30–70 $\mu\Omega\cdot\text{cm}$ Conductive diffusion barrier

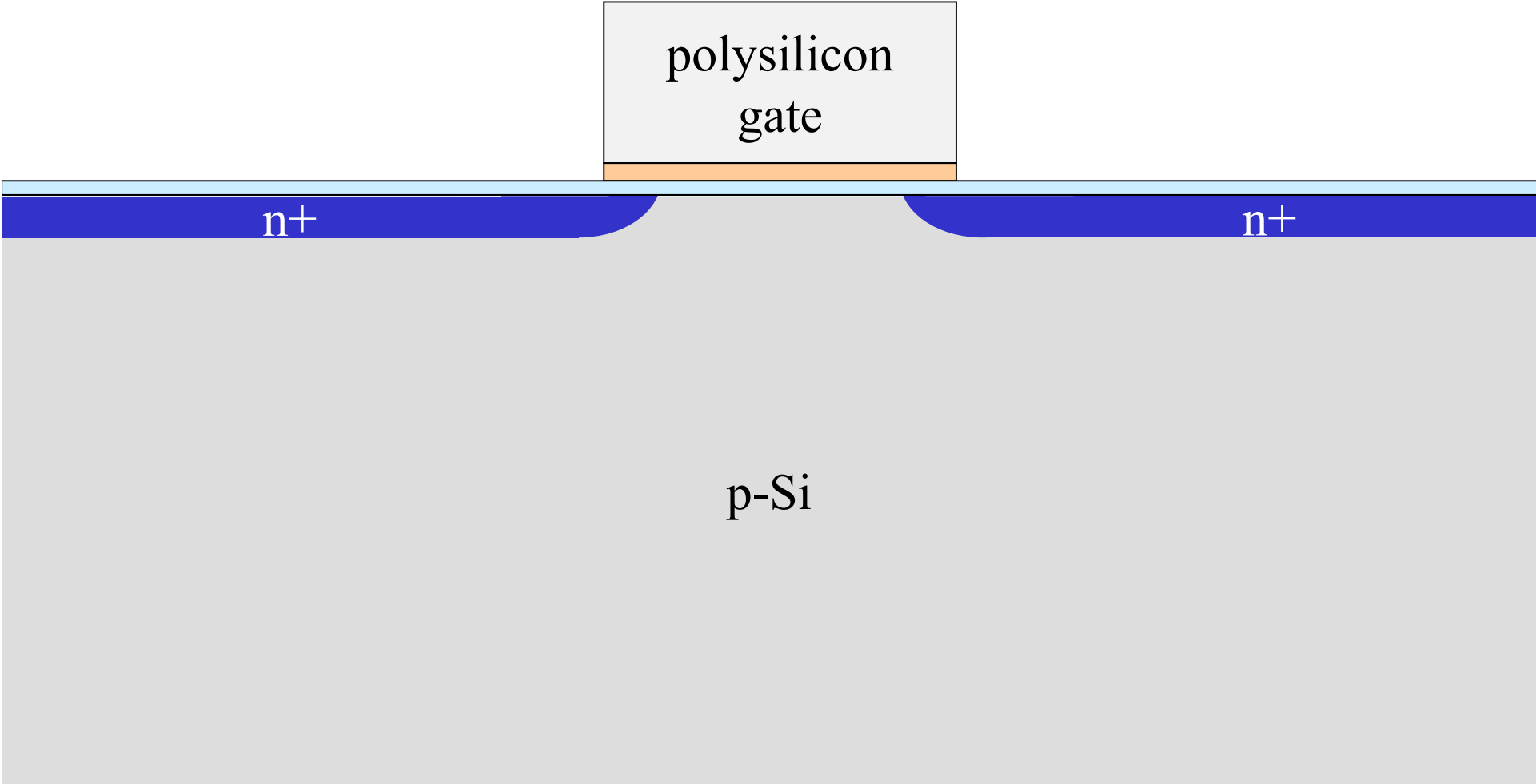
p-Si



Implant



Self-aligned fabrication



Spacer

PECVD SiN_x

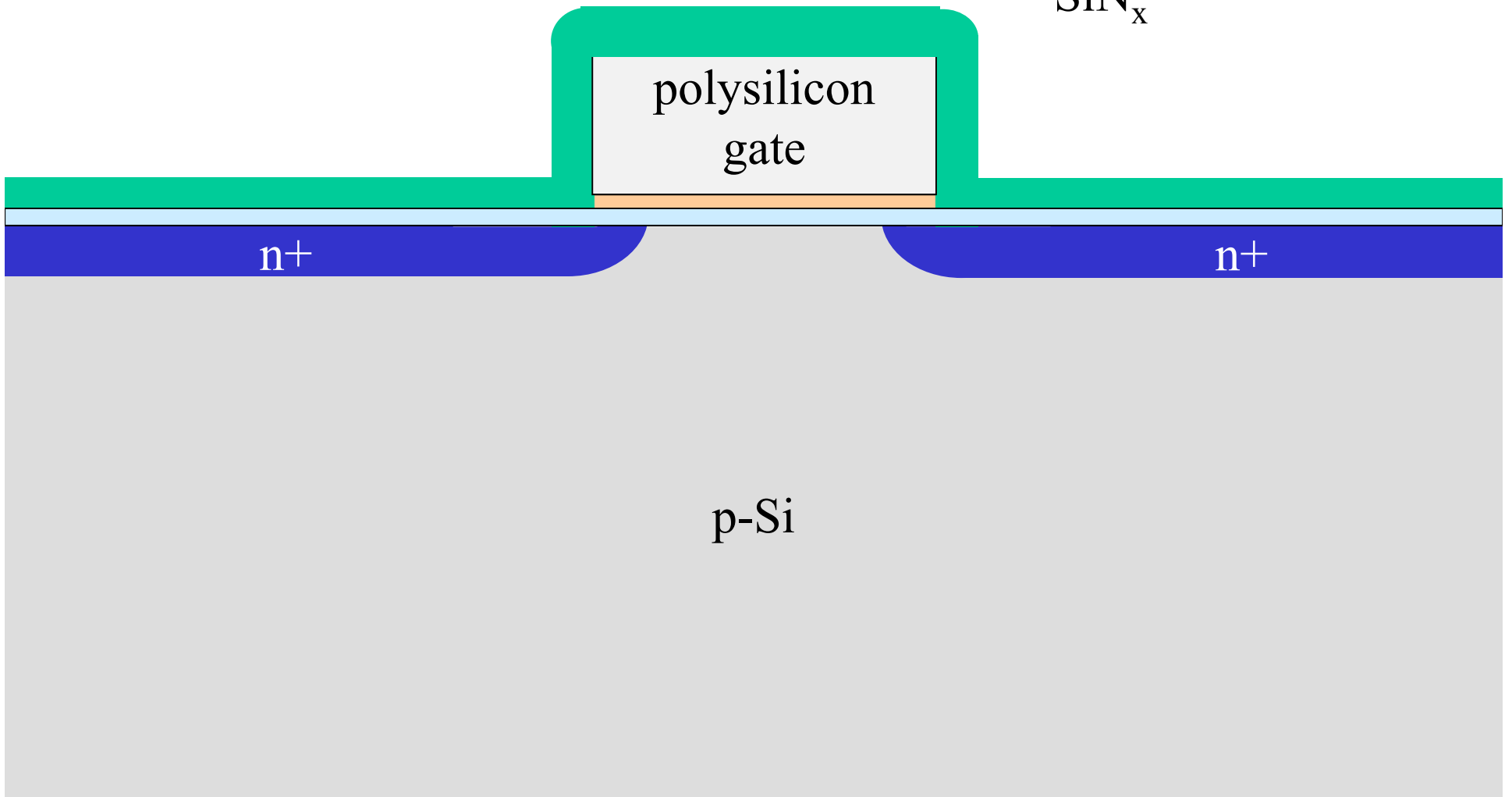
SiN_x

polysilicon
gate

n+

n+

p-Si



Spacer

Etch back to
leave only
sidewalls

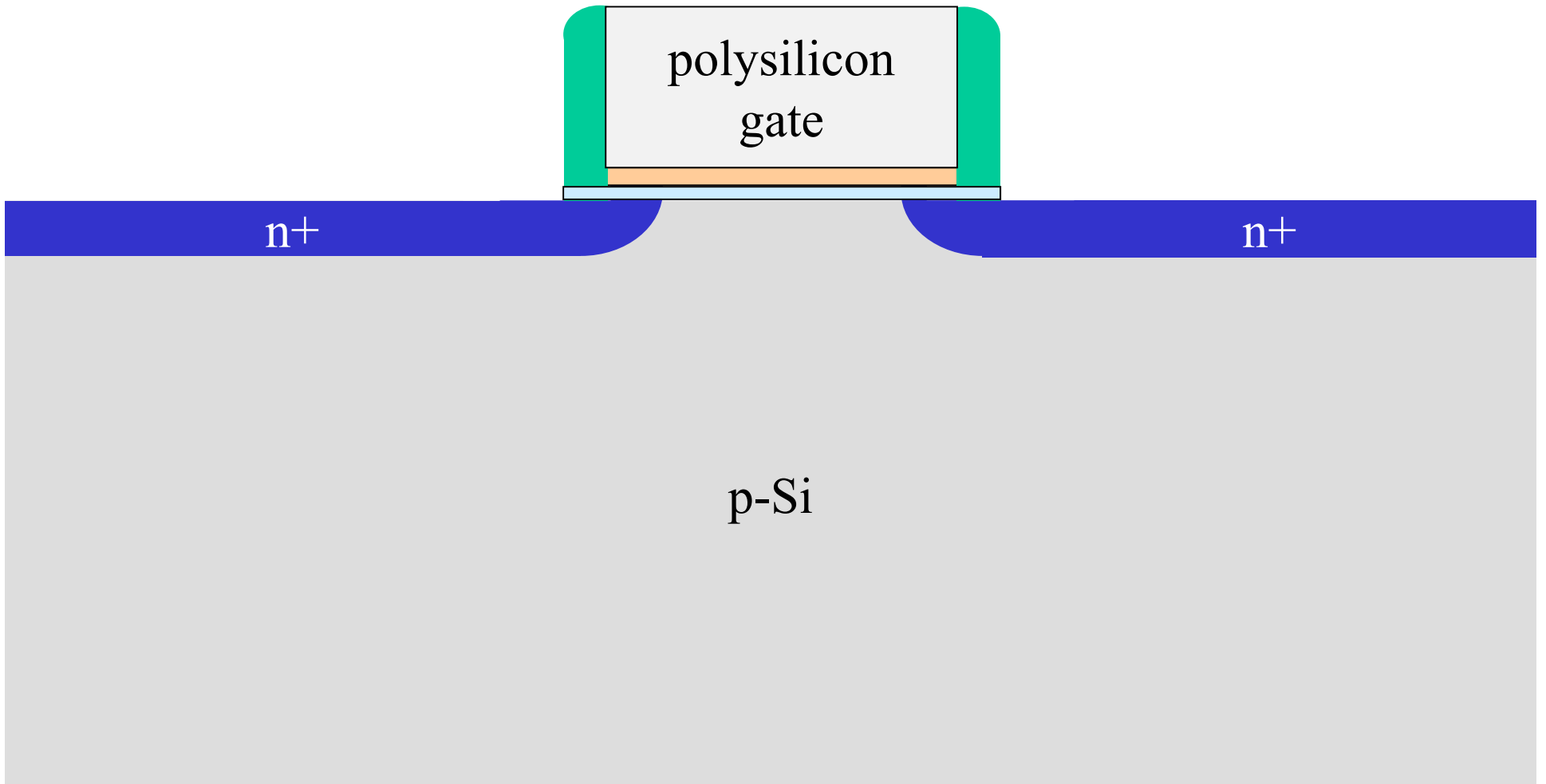
SiN_x

polysilicon
gate

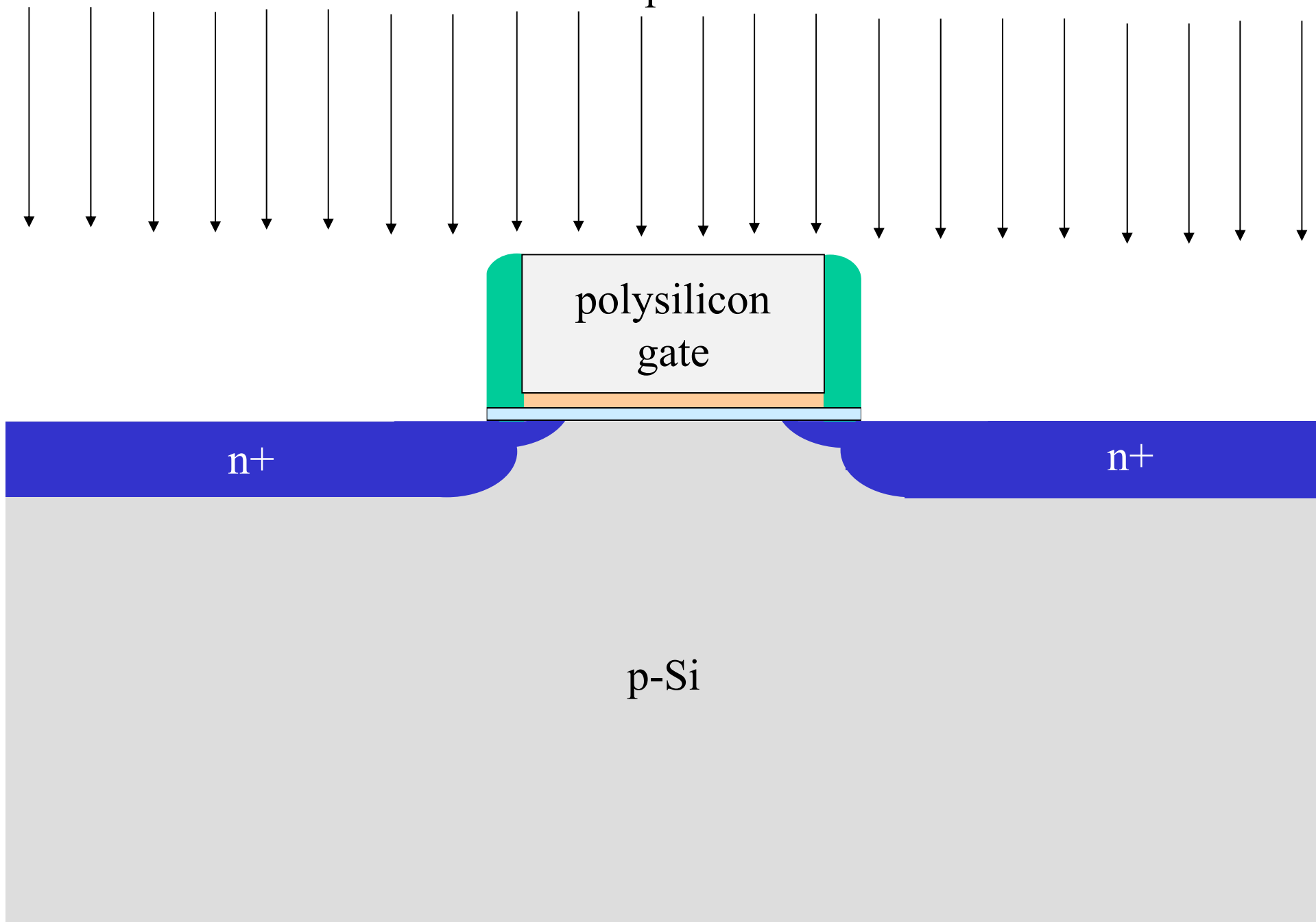
n+

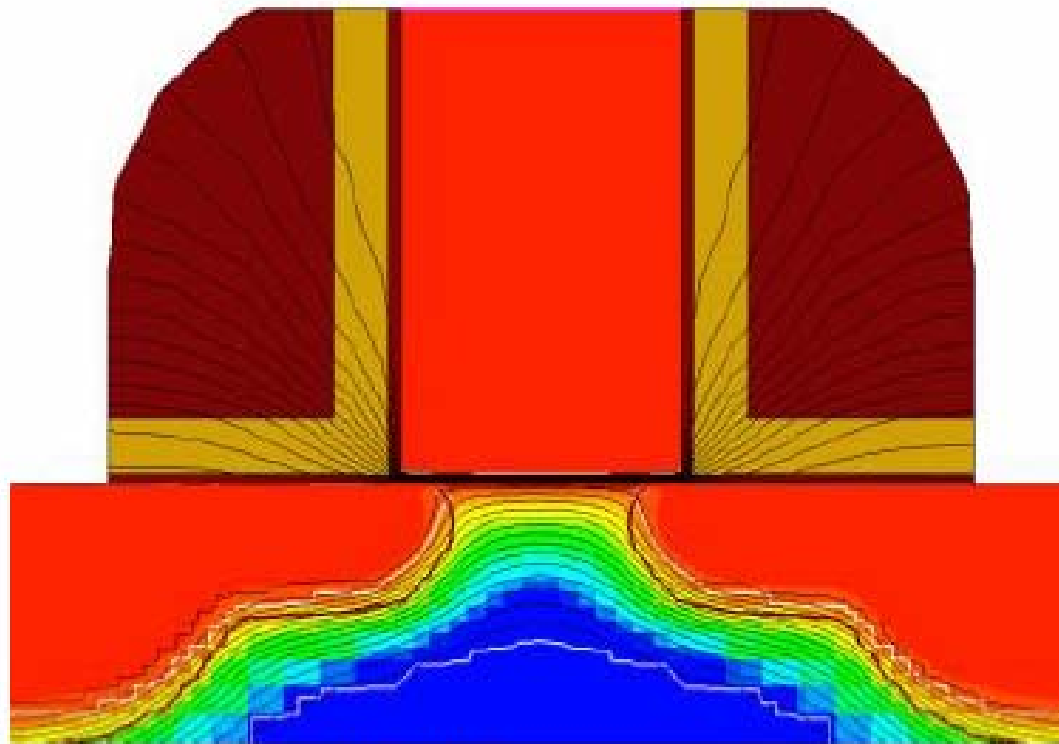
n+

p-Si



Implant





MOSFET in TCAD

CMOS

NMOS is n-channel so it should be in a p-well

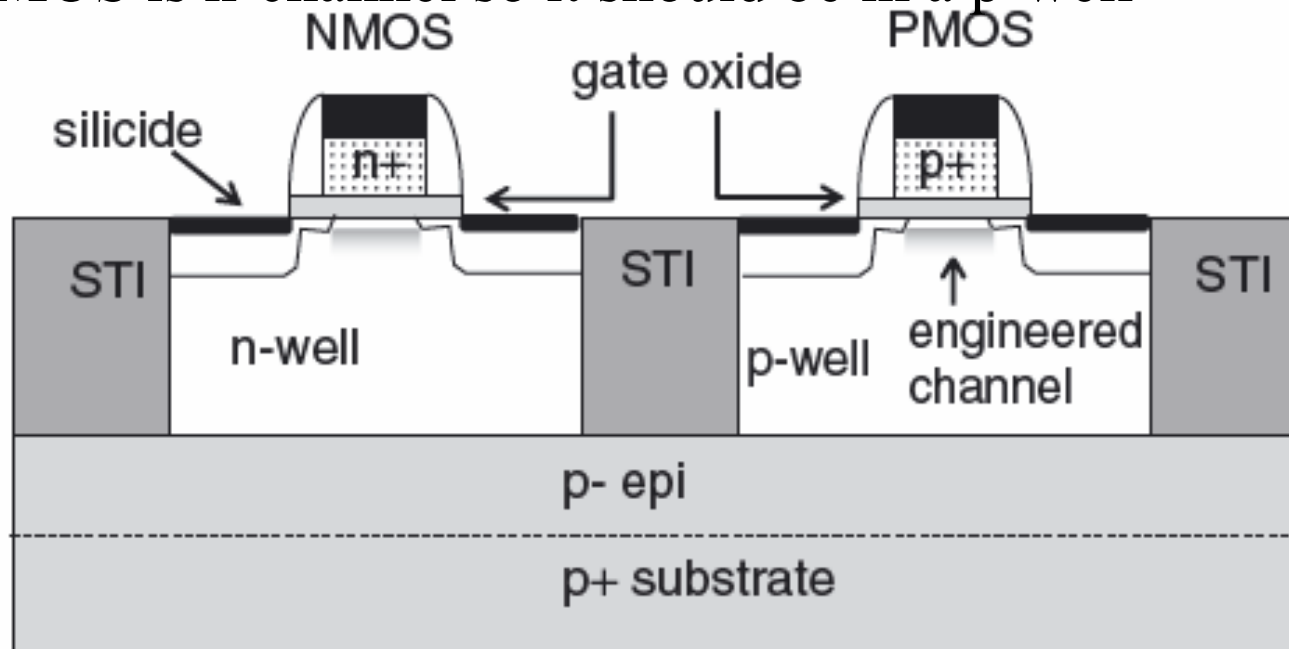
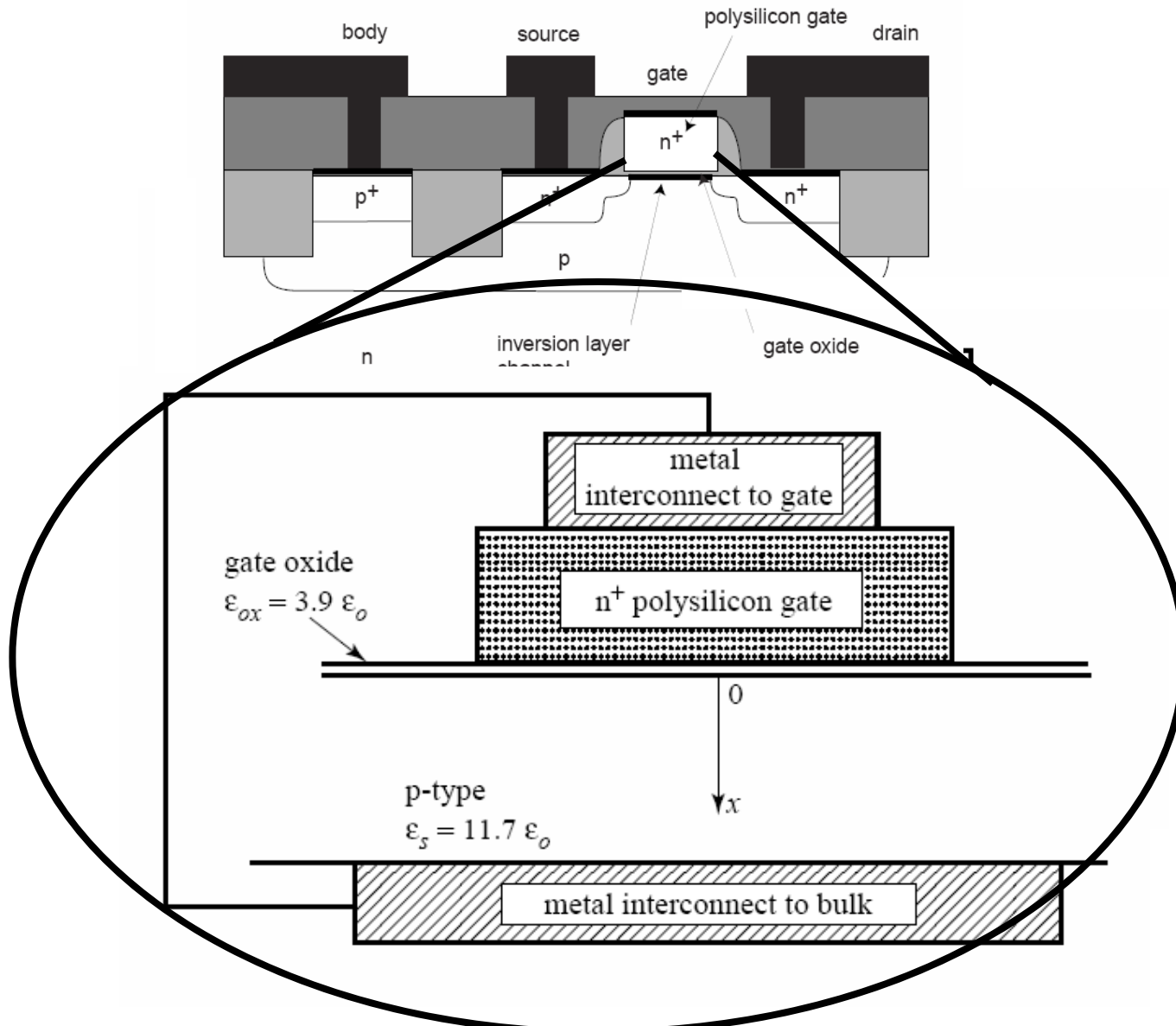


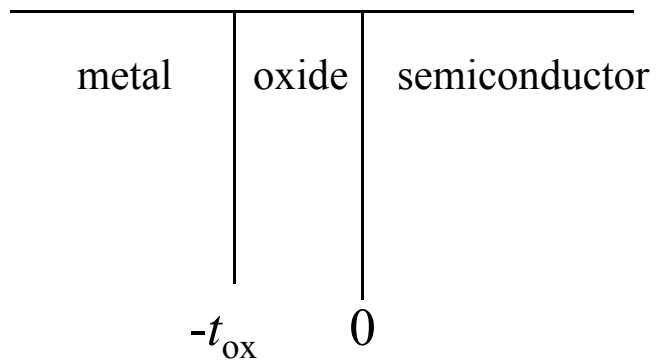
Figure 26.11 Deep submicron CMOS: 200 nm gate length, 5 nm gate oxide, 70 nm junction depth; n⁺ poly for NMOS and p⁺ poly for PMOS. Shallow trench isolation on epitaxial n⁺/p⁺ wafer

Source: Fransila

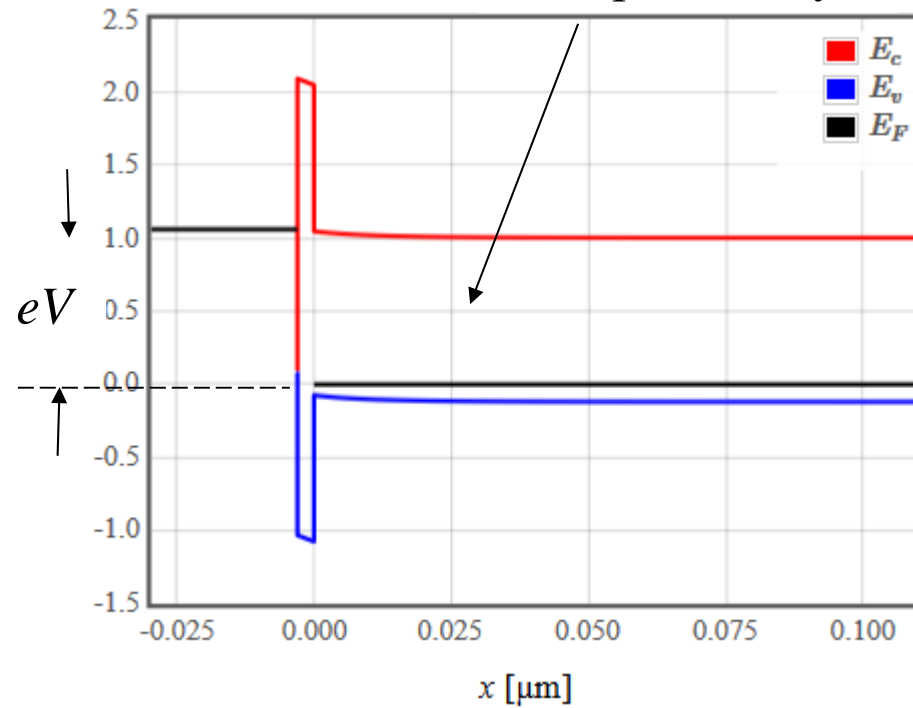
MOS capacitor



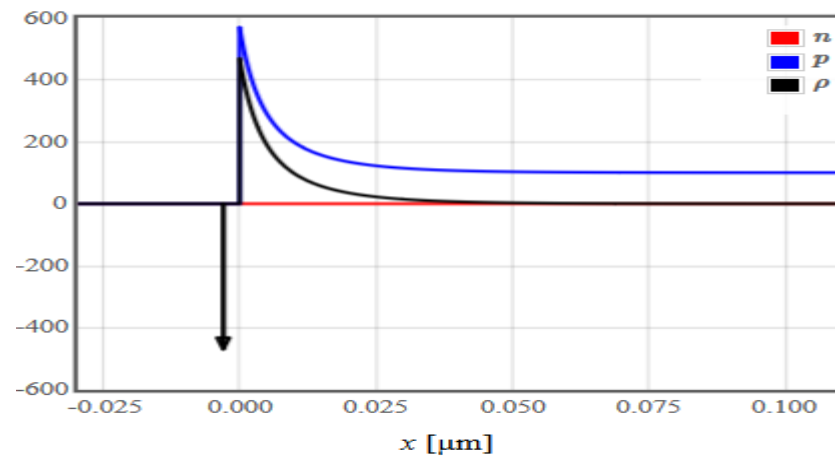
Accumulation



no depletion layer

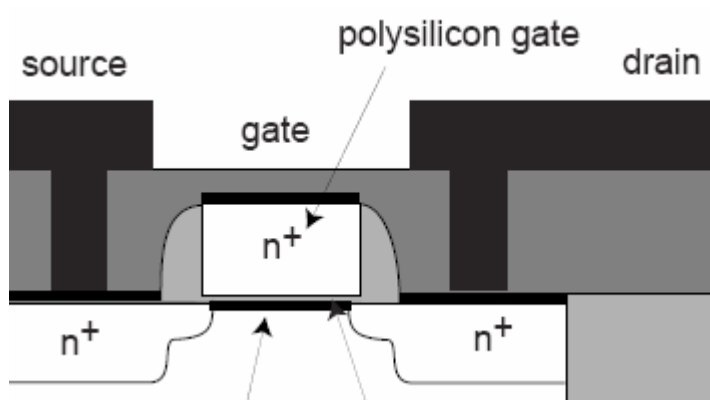
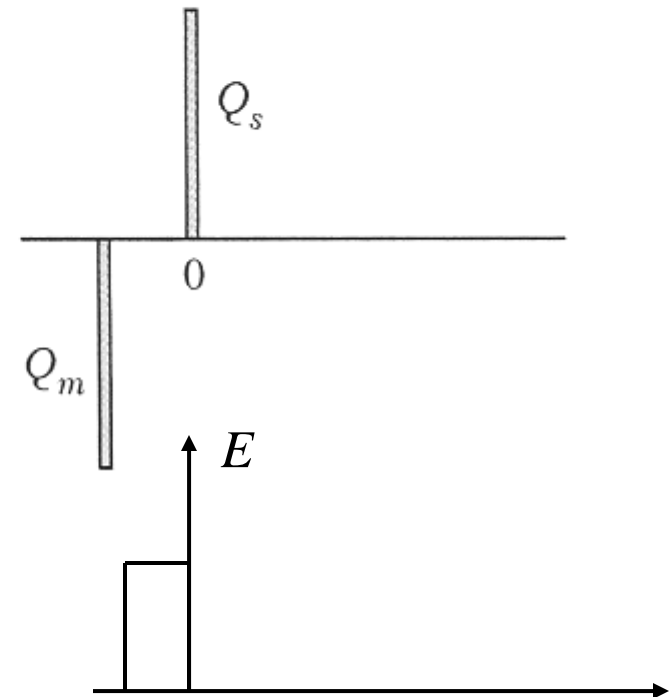
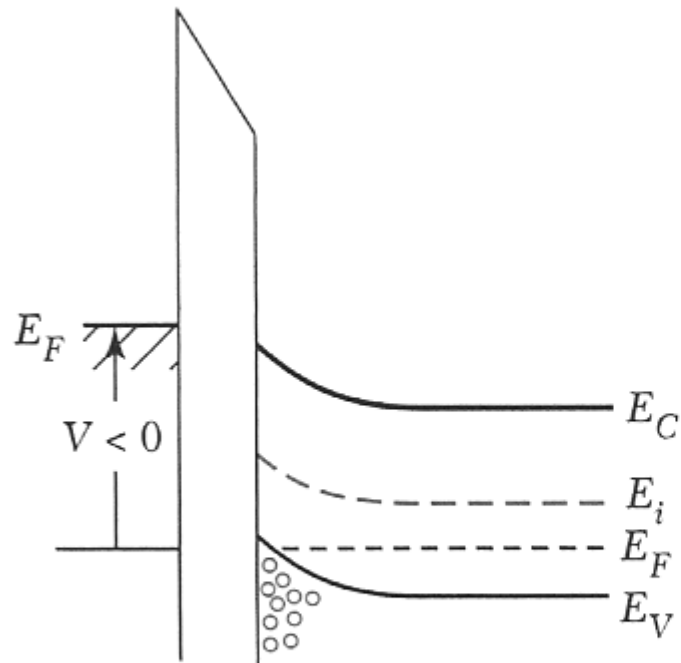


$\rho \times 10^{-15}$
[C/cm³]

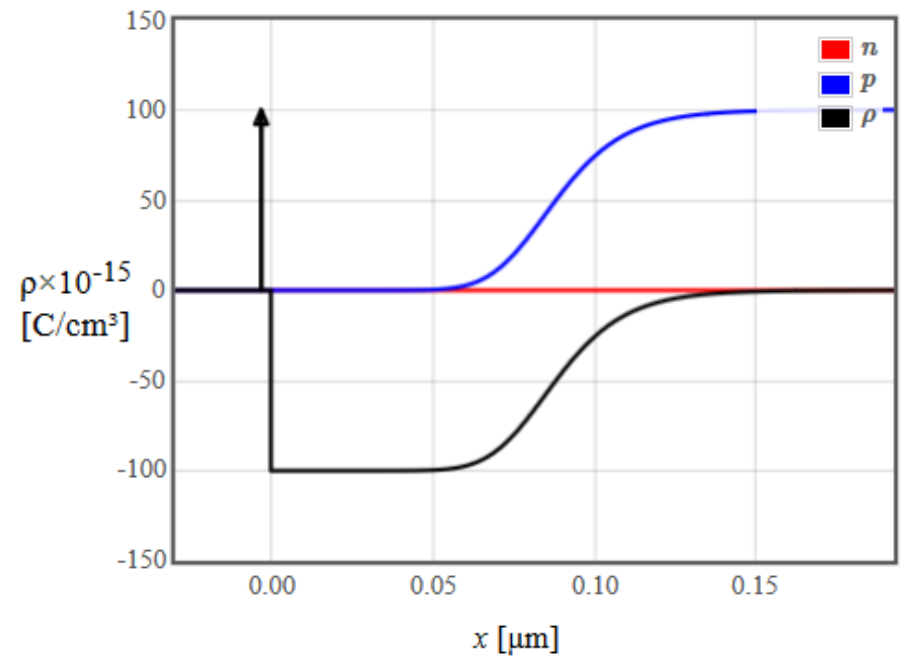
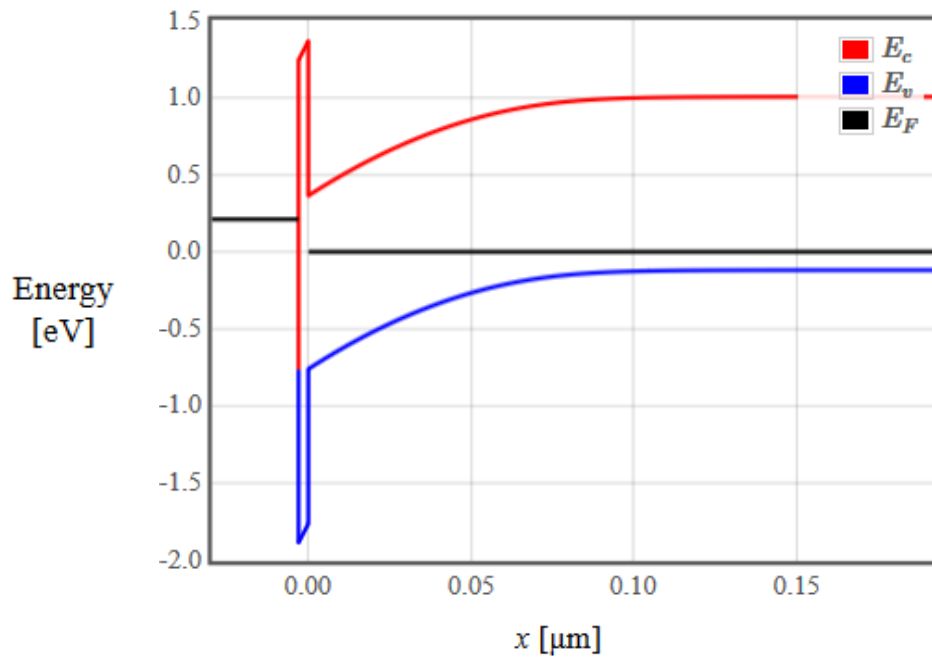


N_A

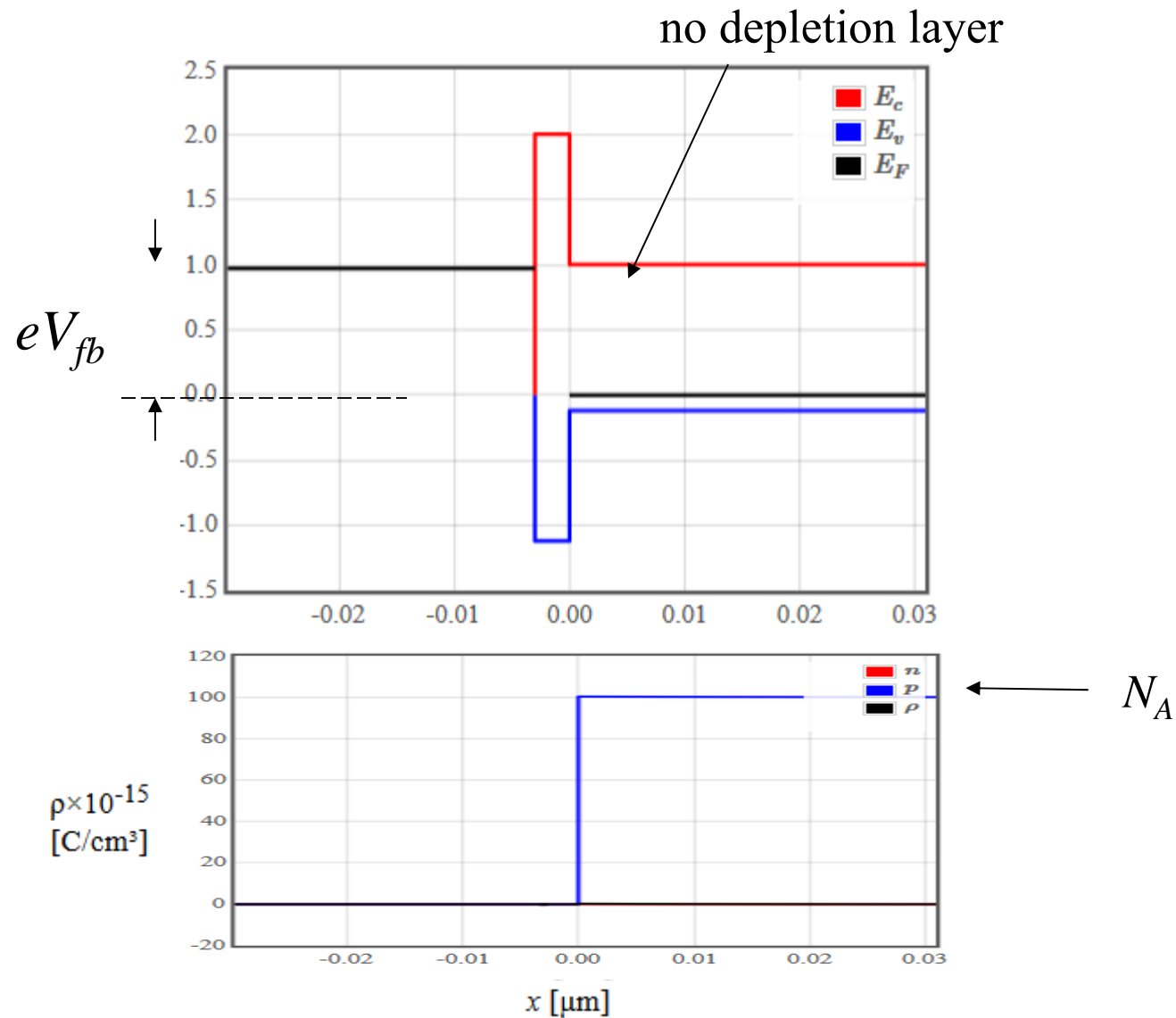
Accumulation



Depletion

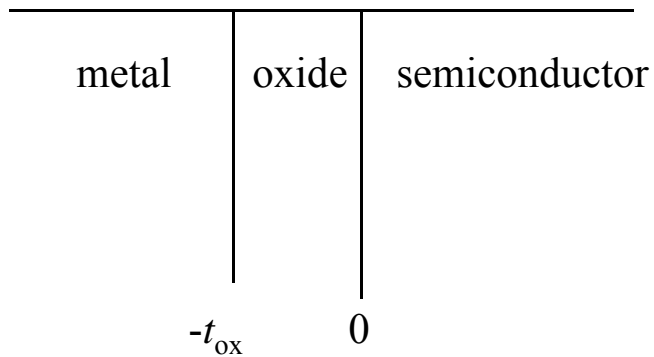


Flat band voltage

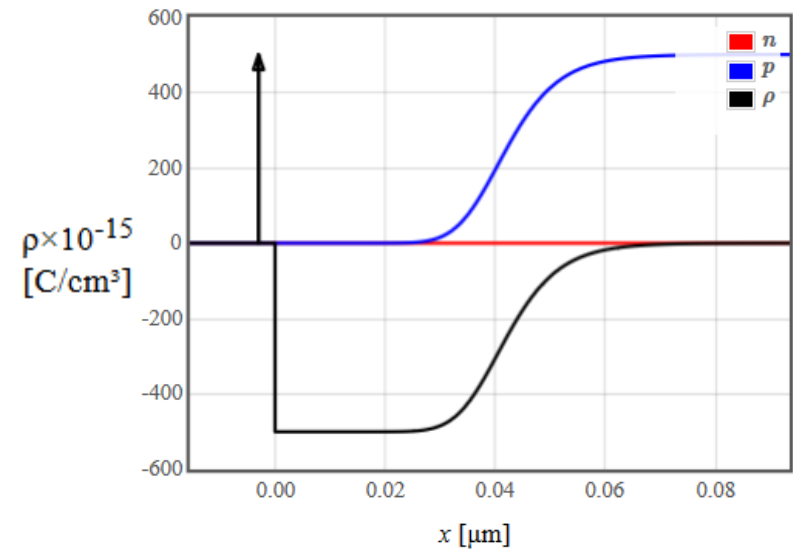
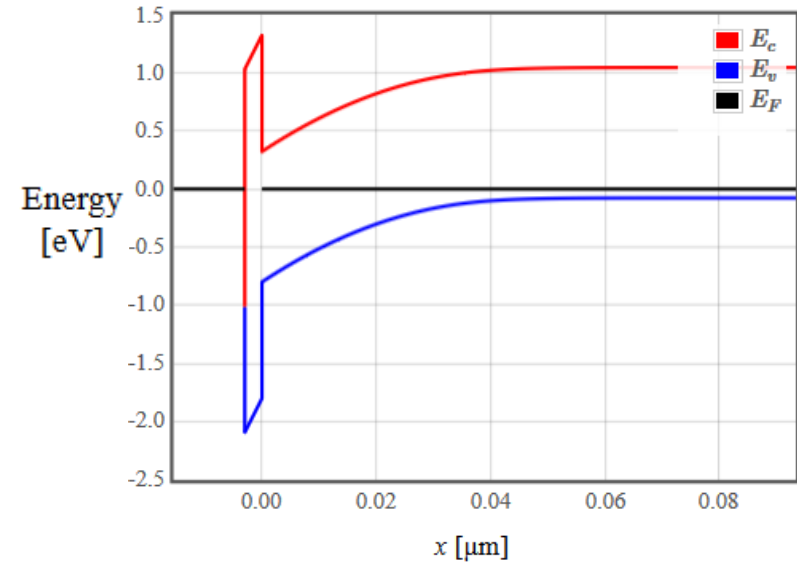


If $\phi_s = \phi_m$, the flatband voltage is the zero bias voltage

Zero bias



$e\phi_m$
 Al 4.1 eV
 p+ poly 4.05 eV
 n+ poly 5.05 eV

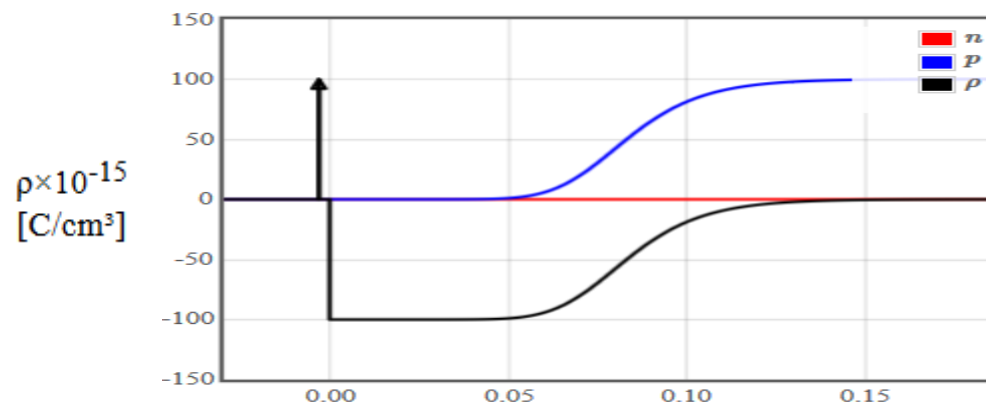
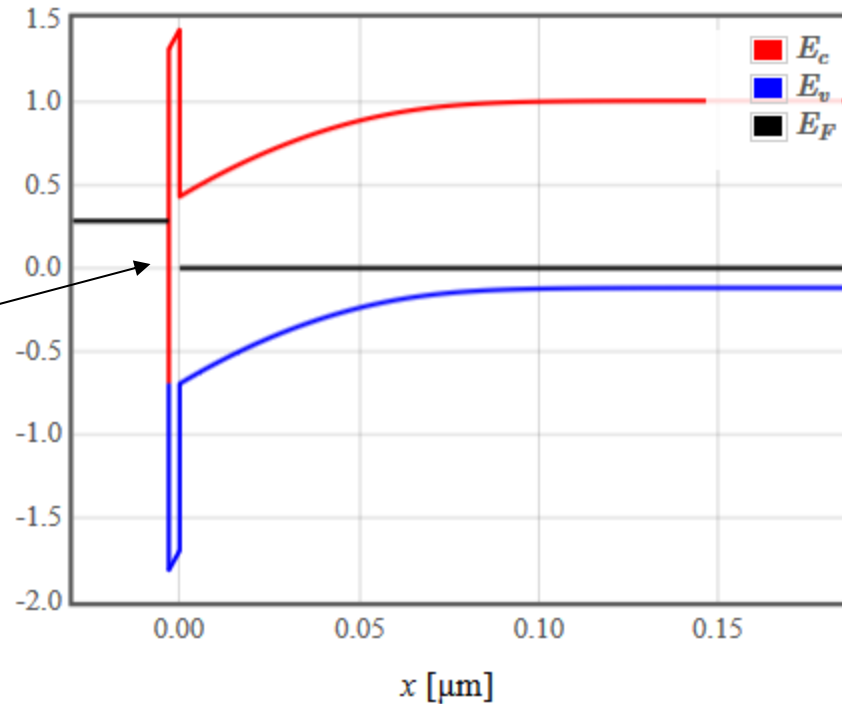


Can be in accumulation or depletion depending on workfunctions

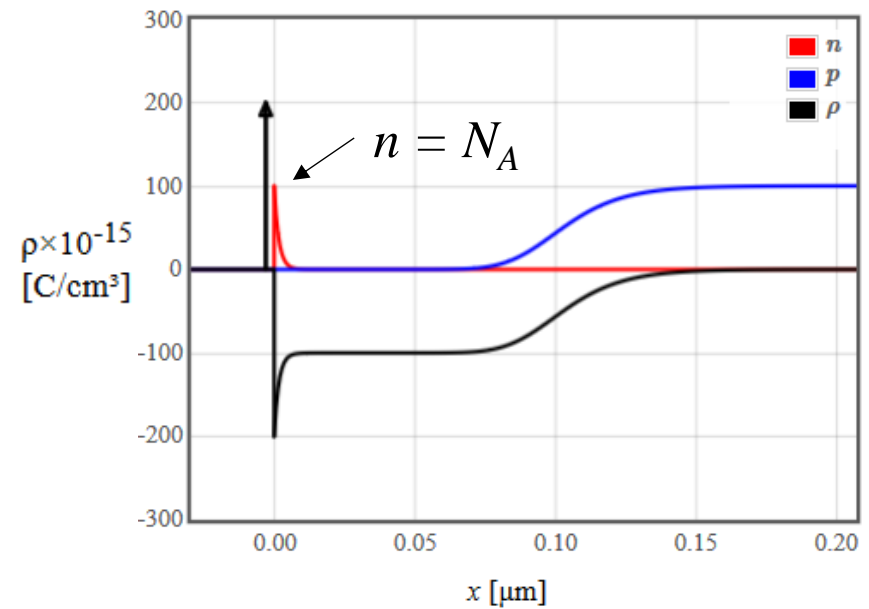
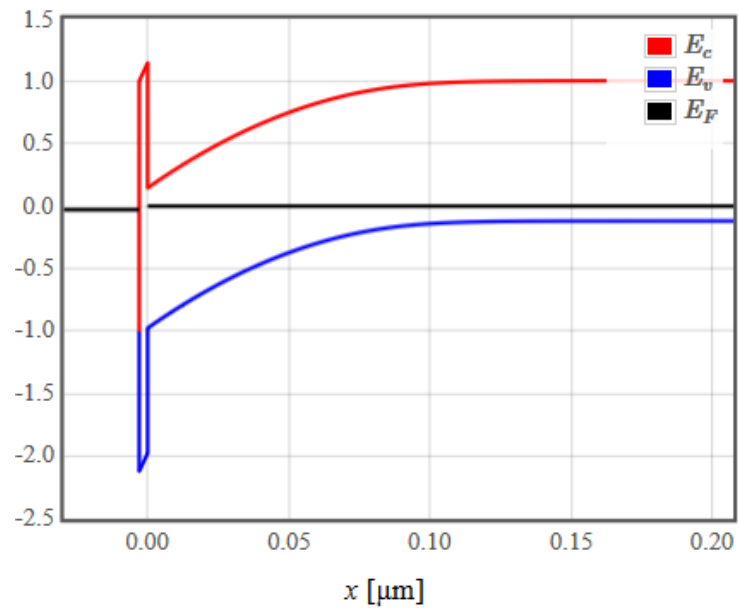
Weak Inversion

Majority carriers at $x = 0$ change from p to n

$n > p$
at the interface



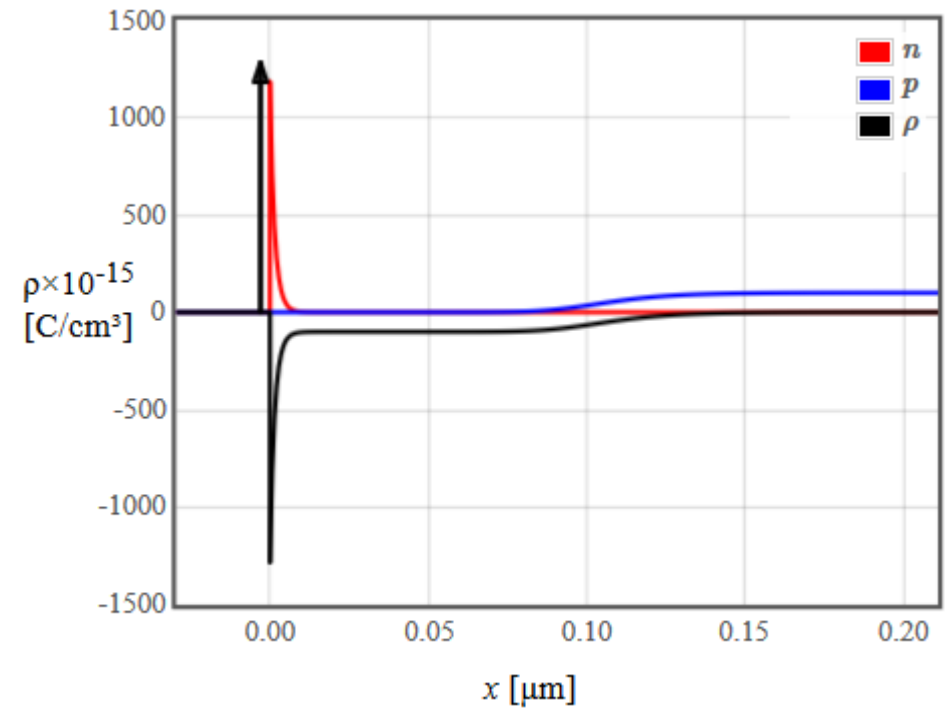
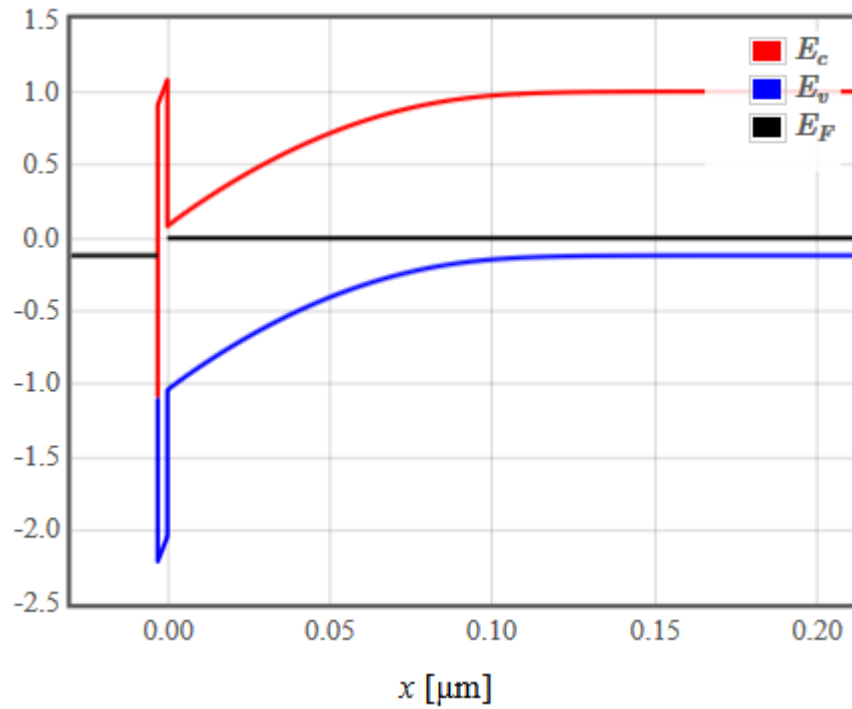
Threshold voltage



Strong inversion: $n = N_A$ at $x = 0$, the semiconductor-oxide interface

Inversion

$n > N_A$ at $x = 0$, the semiconductor-oxide interface



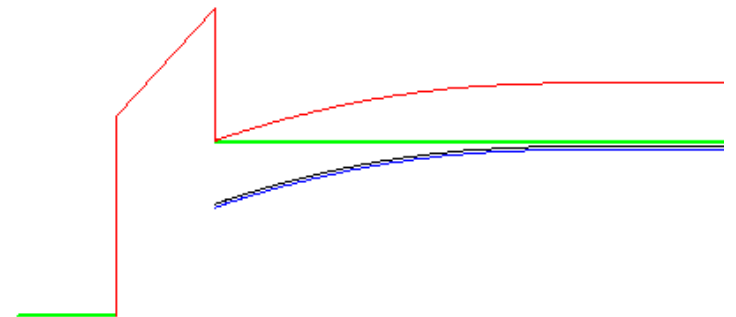
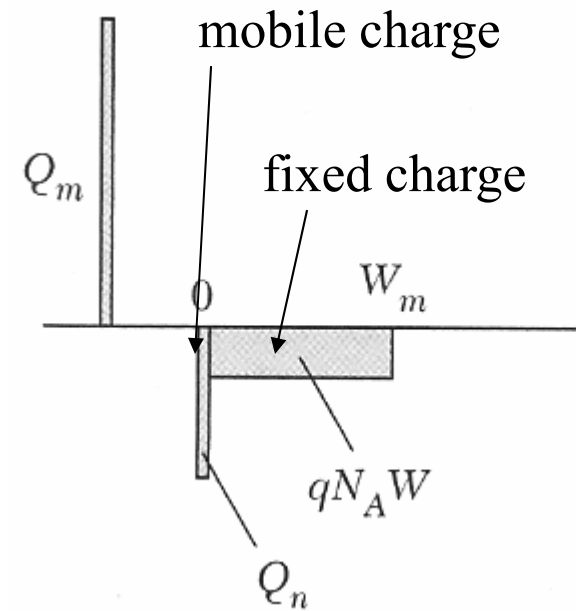
MOS capacitor

In inversion, the charge in the inversion layer is:

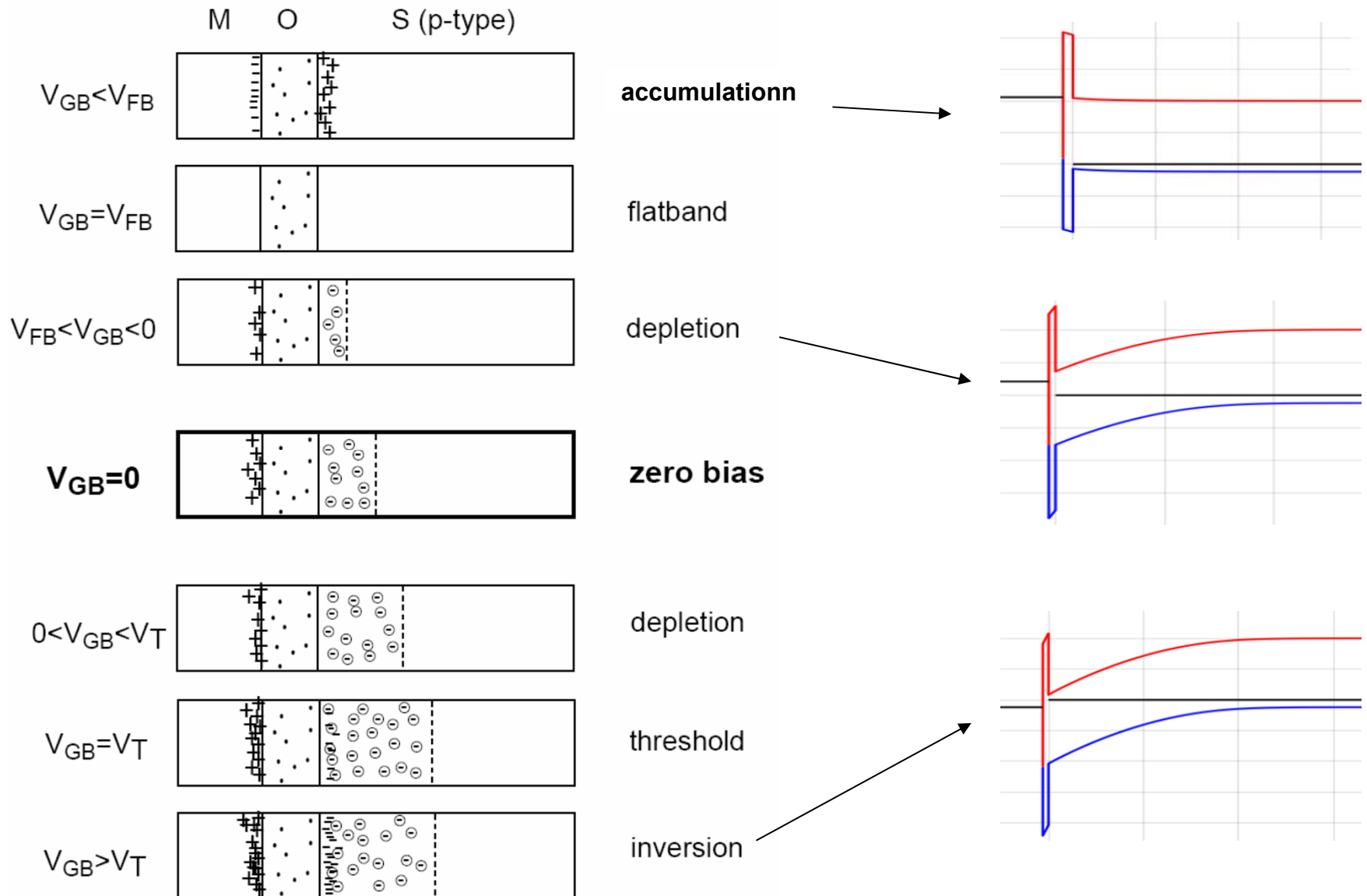
$$Q = -C_{\text{ox}}(V_G - V_B - V_T)$$

Mobile charge per unit area

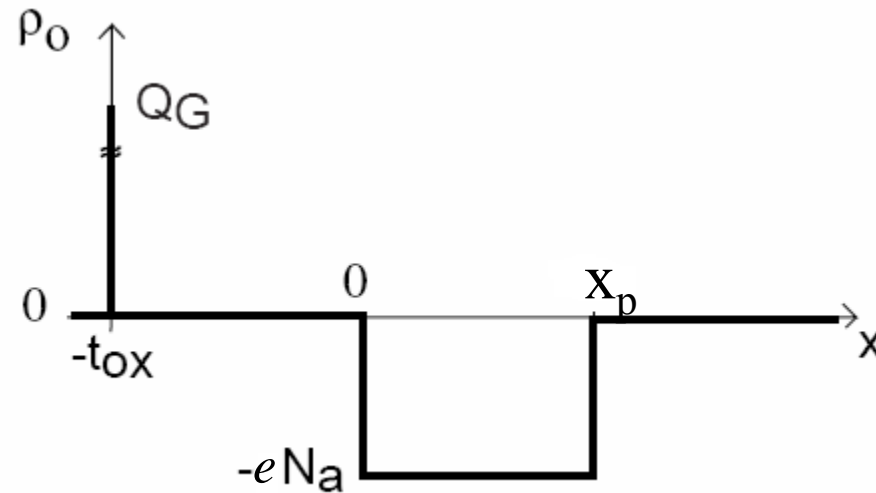
Specific capacitance F/m²



MOS capacitor



charge density (depletion)

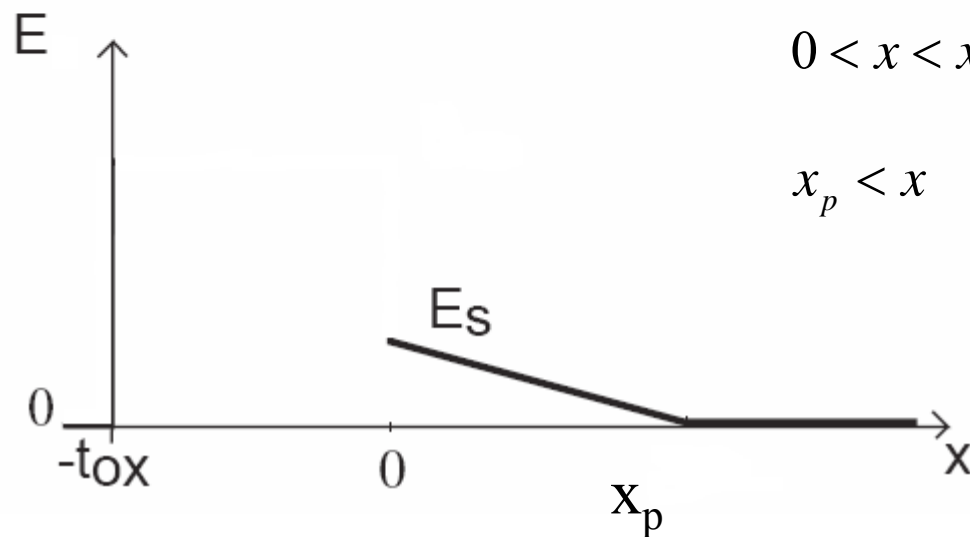
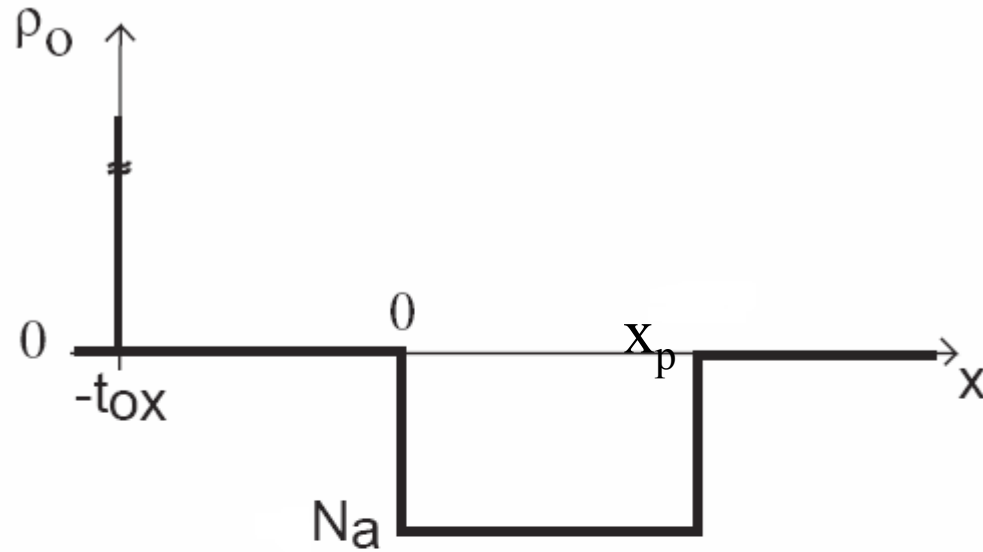


$$-t_{ox} < x < 0 \quad \rho(x) = 0$$

$$0 < x < x_p \quad \rho(x) = -eN_A$$

$$x_p < x \quad \rho(x) = 0$$

electric field



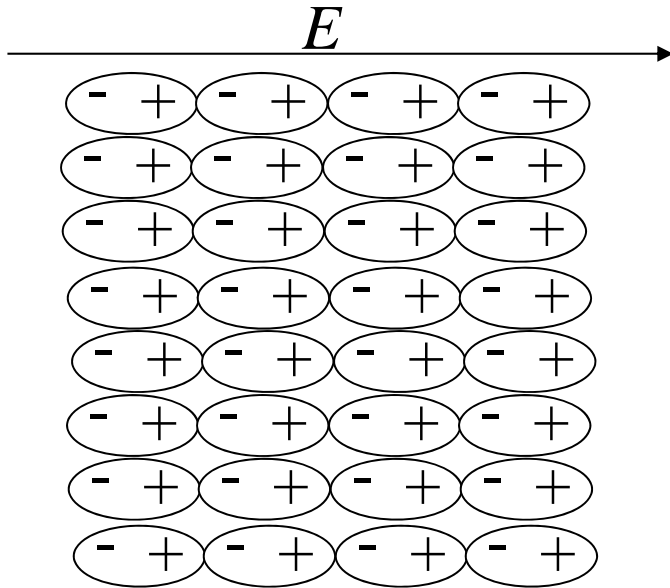
$$0 < x < x_p$$

$$x_p < x$$

$$E(x) = \frac{-eN_A}{\epsilon_s} (x - x_p)$$

$$E(x) = 0$$

electric field (depletion)

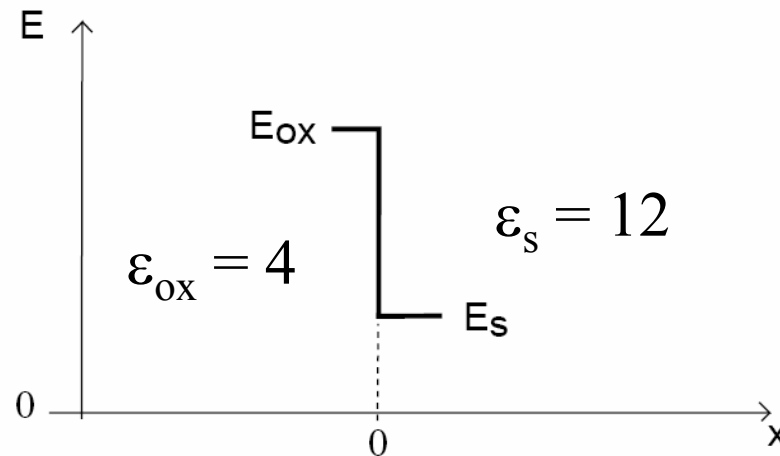


E is decreased by a factor of the dielectric constant

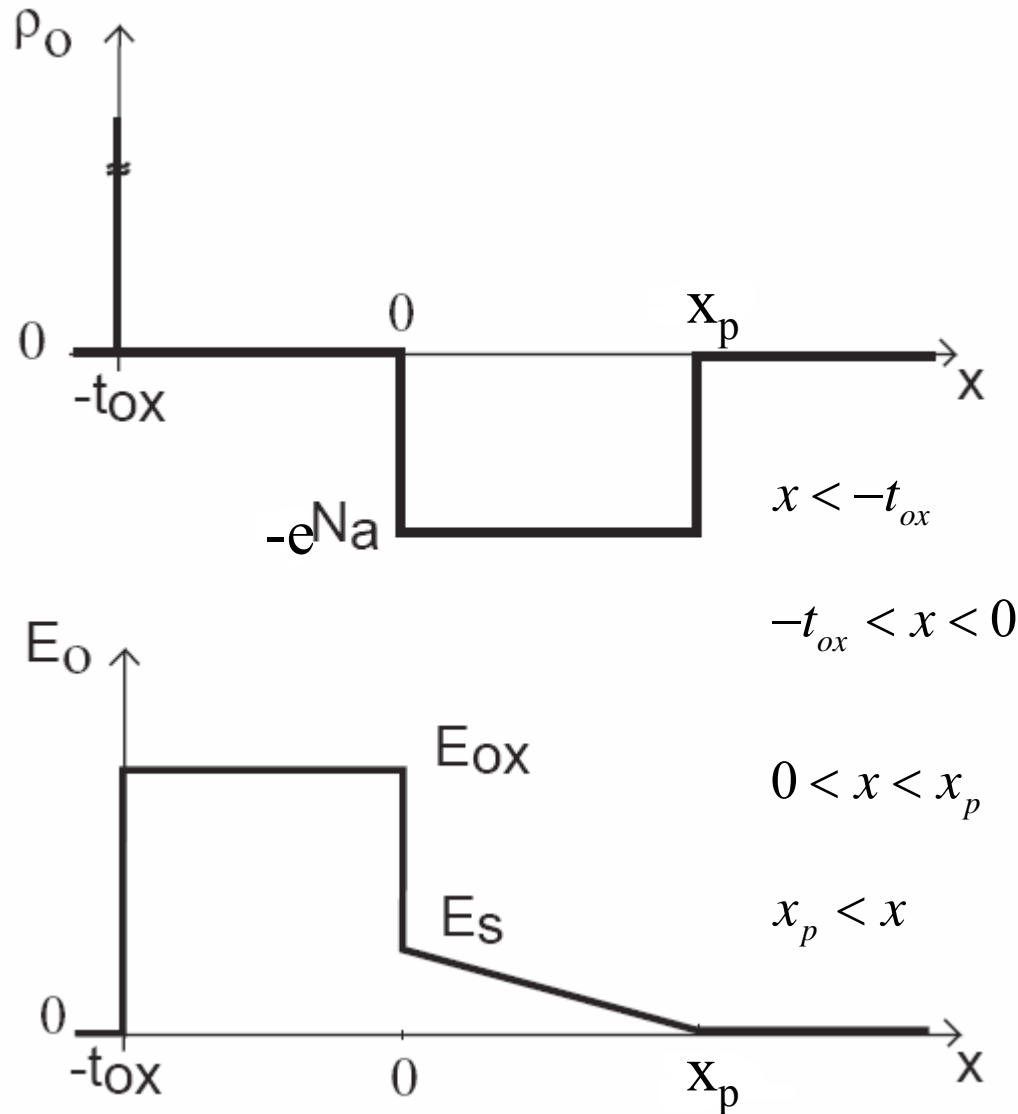
$$\epsilon_r = \frac{E_{vacuum}}{E_{dielectric}}$$

$$\epsilon_{ox} E_{ox} = \epsilon_s E_s$$

$$\frac{E_{ox}}{E_s} = \frac{\epsilon_s}{\epsilon_{ox}} \approx 3$$



electric field



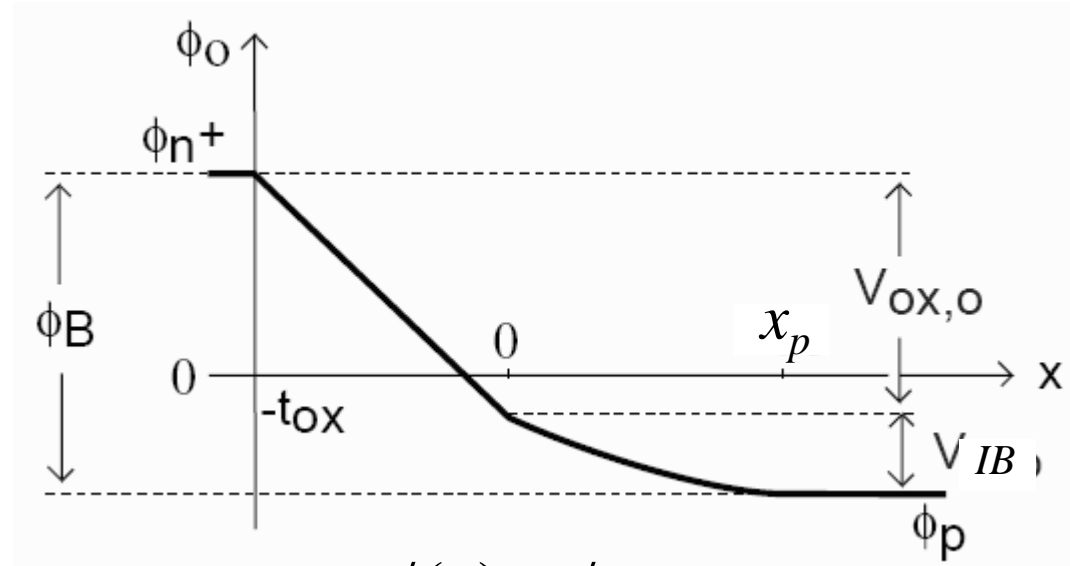
$$E(x) = 0$$

$$E(x) = \frac{\epsilon_s}{\epsilon_{ox}} E(x = 0^+) = \frac{eN_A x_p}{\epsilon_{ox}}$$

$$E(x) = \frac{-eN_A}{\epsilon_s} (x - x_p)$$

$$E(x) = 0$$

electrostatic potential



$$x < -t_{ox} \quad \phi(x) = \phi_{gate}$$

$$-t_{ox} < x < 0 \quad \phi(x) = \phi_p + \frac{eN_A x_p^2}{2\epsilon_s} + \frac{eN_A x_p}{\epsilon_{ox}} (-x)$$

$$0 < x < x_p \quad \phi(x) = \phi_p + \frac{eN_A}{2\epsilon_s} (x - x_p)^2$$

$$x_p < x \quad \phi(x) = \phi_p$$

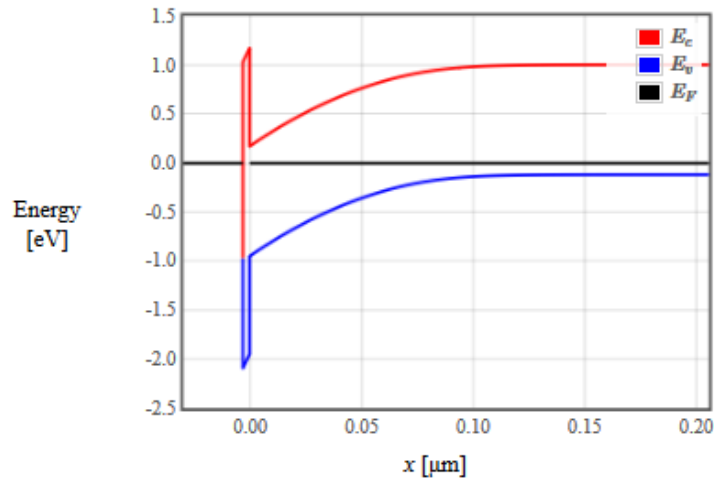
(We still don't know x_p)

MOS Capacitor - Solving the Poisson Equation

The app below solves the Poisson equation to determine the band bending, the charge distribution, and the electric field in a MOS capacitor with a p-type substrate.

$\phi_m =$ <input type="text" value="4.08"/> eV	$\chi_s =$ <input type="text" value="4.05"/> eV	$N_c(300) =$ <input type="text" value="2.78E19"/> 1/cm ³	$T =$ <input type="text" value="300"/> K
$t_{ox} =$ <input type="text" value="3"/> nm	$\epsilon_{ox} =$ <input type="text" value="4"/>	$N_v(300) =$ <input type="text" value="9.84E18"/> 1/cm ³	$N_A =$ <input type="text" value="1E17"/> 1/cm ³
$E_g =$ <input type="text" value="1.166-4.73E-4*T*(T+636)"/> eV	$\epsilon_{semi} =$ <input type="text" value="12"/>		
$V =$ <input type="text" value="0"/> V			
<input type="button" value="-"/> <input type="button" value="+"/>		<input type="button" value="Submit"/> <input type="button" value="Si"/> <input type="button" value="Ge"/> <input type="button" value="GaAs"/>	

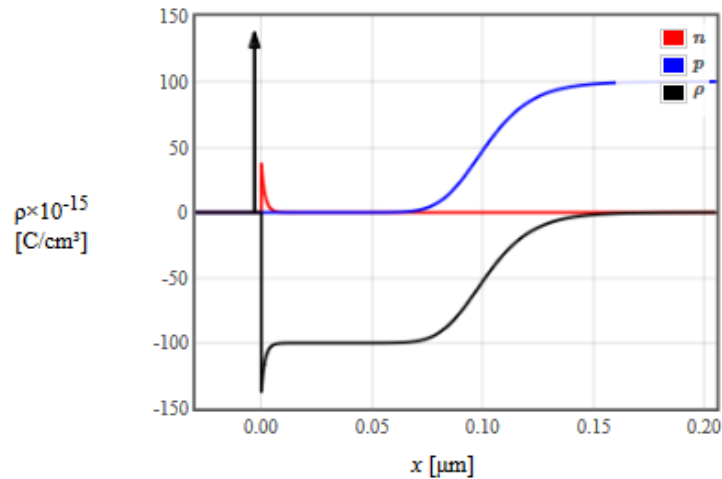
Band diagram



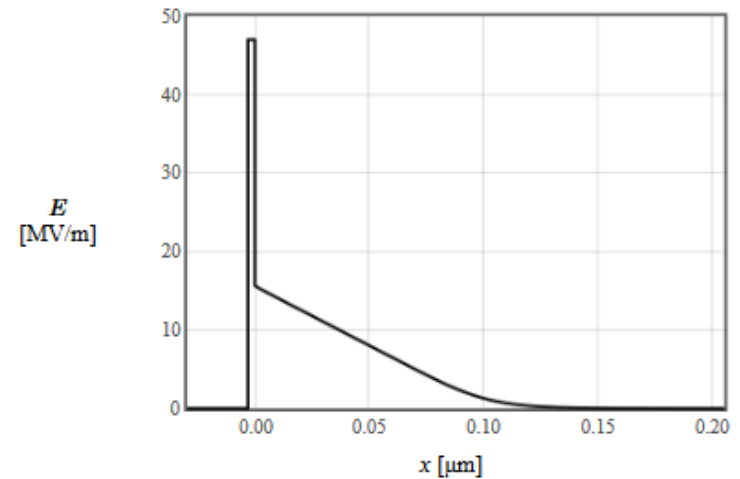
$E_g = 1.12$ eV	$n_i = 6.40e+9$ 1/cm ³
$E_s = 1.57e+7$ V/m	$V_s = 0.831$ V
$Q = -0.00167$ C/m ²	$V_{shoot} = 0.0000221$ V
$E_{ox} = 4.70e+7$ V/m	$V_{fb} = \phi_m - \phi_s = -0.972$ V
$\phi_s = 5.05$ eV	

From the depletion approximation:
 $\max(x_p) 0.107 \mu\text{m}$ $V_T = 0.0292$ V

Charge density



Electric field



Band bending at inversion

$$n = N_A \text{ at threshold}$$

Far on the p side

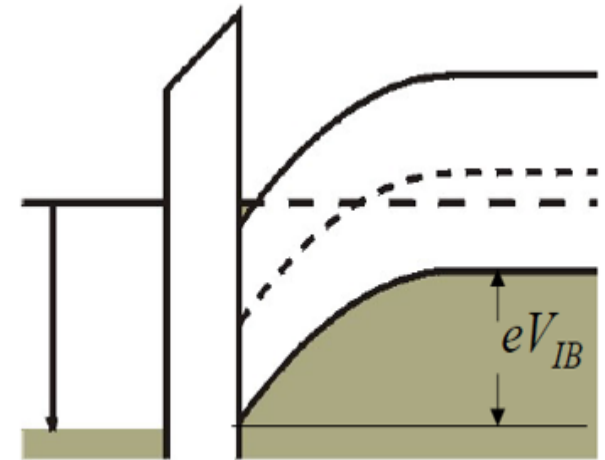
$$n = \frac{n_i^2}{N_A} = N_c \exp\left(\frac{E_F - E_c}{k_B T}\right) \quad E_F - E_c = k_B T \ln\left(\frac{n_i^2}{N_A N_c}\right)$$

At the interface, $n = N_A$

$$N_A = N_c \exp\left(\frac{E_F - E_c}{k_B T}\right) \quad E_F - E_c = k_B T \ln\left(\frac{N_A}{N_c}\right)$$

The voltage between the semiconductor-oxide interface and the body

$$eV_{IB} = k_B T \ln\left(\frac{N_A}{N_c}\right) - k_B T \ln\left(\frac{n_i^2}{N_A N_c}\right)$$



V_{IB} is the voltage between the interface and the body

Strong inversion

$n_s = N_A$ at the semiconductor-oxide interface

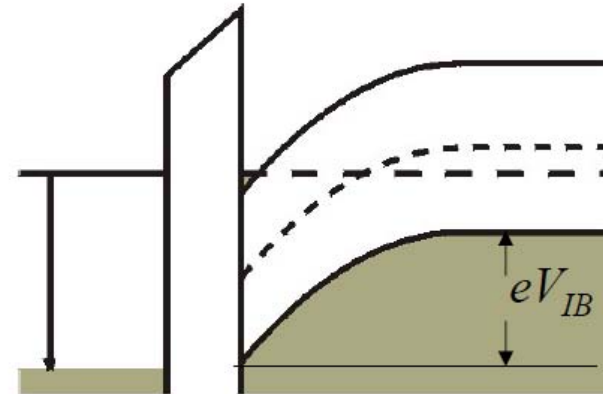
$$eV_{IB} = k_B T \ln\left(\frac{N_A}{N_c}\right) - k_B T \ln\left(\frac{n_i^2}{N_A N_c}\right)$$

$$\ln(a) - \ln(b) = \ln\left(\frac{a}{b}\right)$$

$$eV_{IB} = k_B T \ln\left(\frac{N_A^2}{n_i^2}\right)$$

$$\ln(a^2) = 2 \ln(a)$$

$$eV_{IB} = 2k_B T \ln\left(\frac{N_A}{n_i}\right)$$



The depletion width remains constant in inversion.

Depletion width in inversion

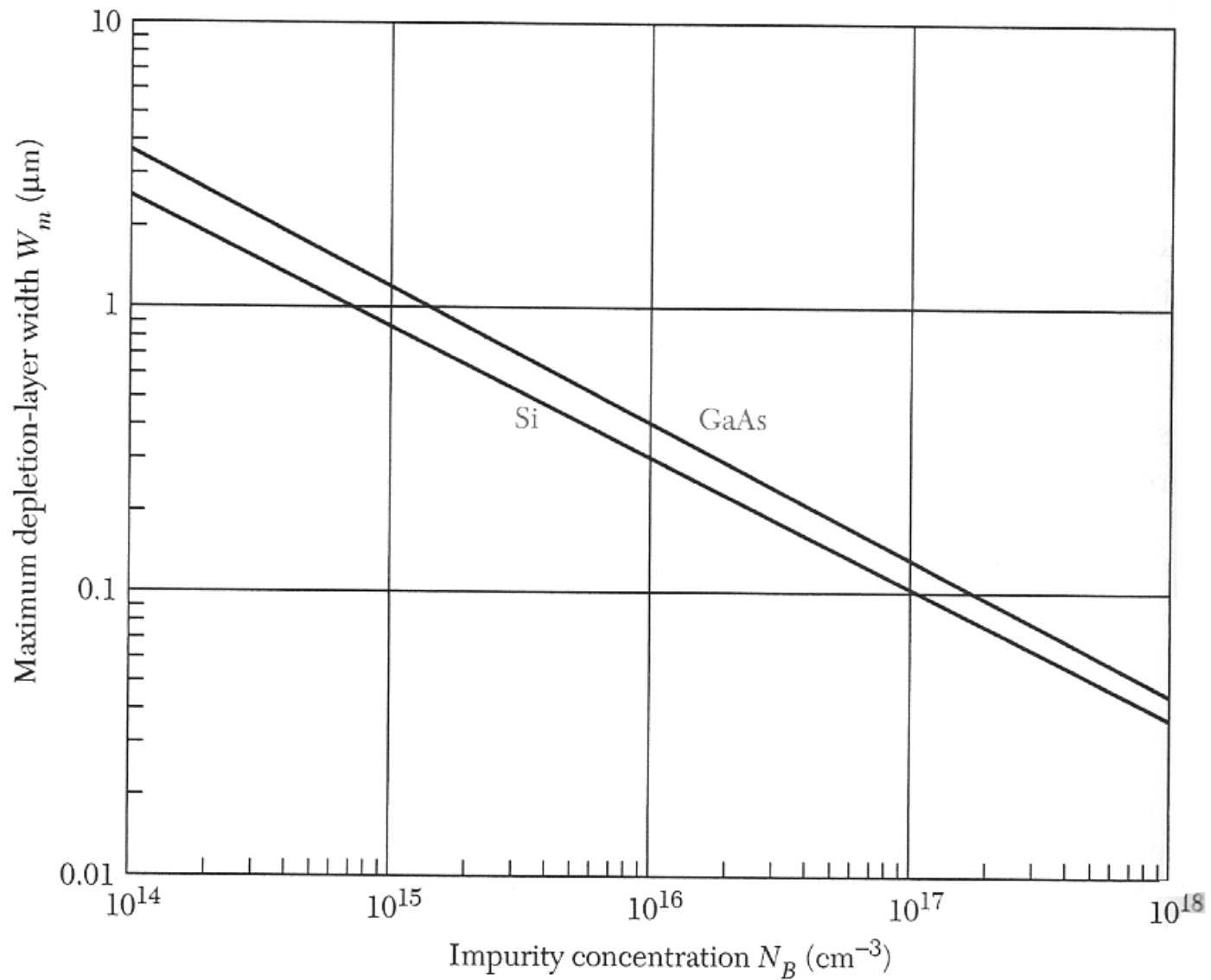
$$V_{IB} = \frac{eN_A x_p^2}{2\varepsilon}$$

$$eV_{IB} = 2k_B T \ln \left(\frac{N_A}{n_i} \right)$$

$$x_{p(\max)} = \sqrt{\frac{2\varepsilon V_{IB}}{eN_A}} = 2 \sqrt{\frac{\varepsilon}{e^2 N_A} k_B T \ln \left(\frac{N_A}{n_i} \right)}$$

The depletion width remains constant in inversion.

Depletion width



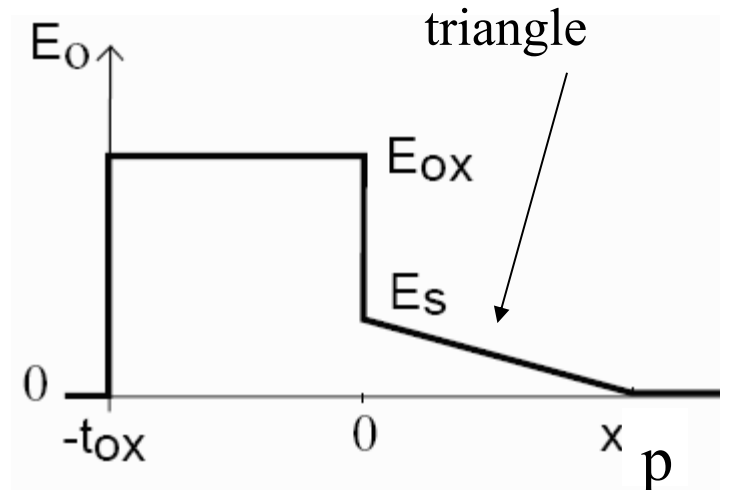
Electric field at semi-oxide interface at strong inversion

$$eV_{IB}(\text{strong inversion}) = 2k_B T \ln\left(\frac{N_A}{n_i}\right)$$

$$E_s = 2 \frac{V_{IB}}{x_{p(\max)}} = \frac{2V_{IB}}{\sqrt{\frac{2\epsilon V_{IB}}{eN_A}}} = 2 \sqrt{\frac{N_A}{\epsilon} k_B T \ln\left(\frac{N_A}{n_i}\right)}$$

$$E_{ox} = \frac{\epsilon}{\epsilon_{ox}} E_s = \frac{2\epsilon}{\epsilon_{ox}} \sqrt{\frac{N_A}{\epsilon} k_B T \ln\left(\frac{N_A}{n_i}\right)}$$

$V_{IB} = E_s x_p / 2 =$
area of the

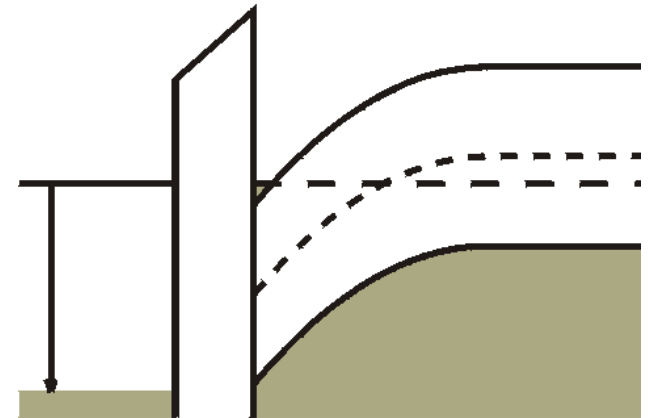


Threshold voltage

$$V_T = E_{ox}(\text{strong inversion})t_{ox} + V_{IB}(\text{strong inversion}) + V_{FB}$$

$$V_T = \frac{2\epsilon t_{ox}}{\epsilon_{ox}} \sqrt{\frac{N_A k_B T \ln\left(\frac{N_A}{n_i}\right)}{\epsilon}} + 2 \frac{k_B T}{e} \ln\left(\frac{N_A}{n_i}\right) + V_{FB}$$

$\frac{\epsilon t_{ox}}{\epsilon_{ox}} E_{inversion}$
 V_{IB}

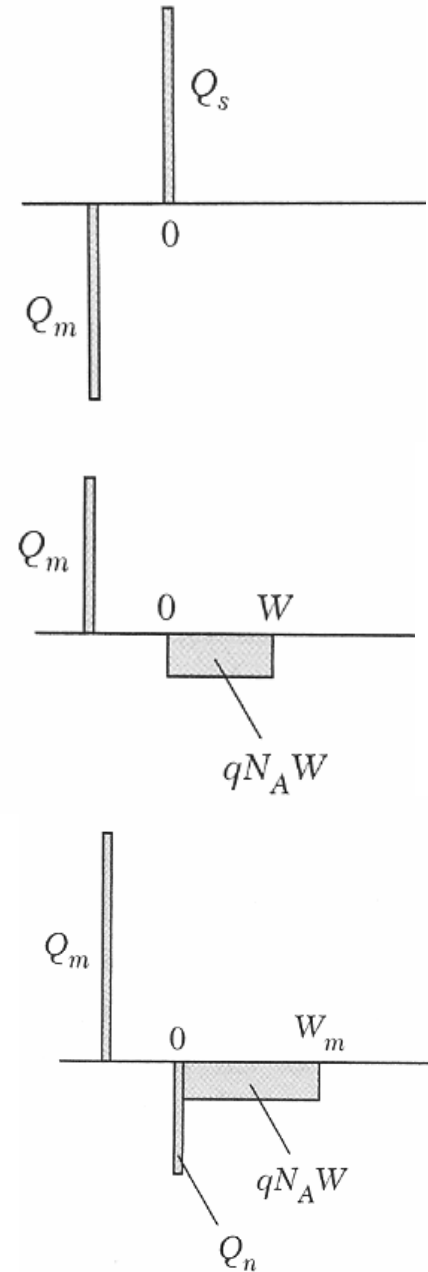
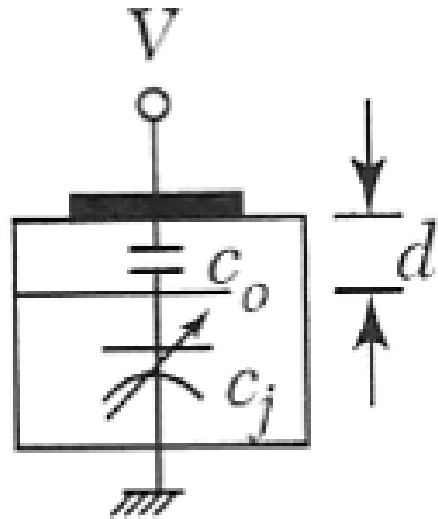


Small V_T requires a small t_{ox} and a large ϵ_{ox} .

MOS capacitance

$$C_{ox} = \frac{\epsilon_{ox}}{t_{ox}} \quad C_j = \frac{\epsilon}{x_p}$$

$$C = \left(\frac{1}{C_{ox}} + \frac{1}{C_j} \right)^{-1}$$

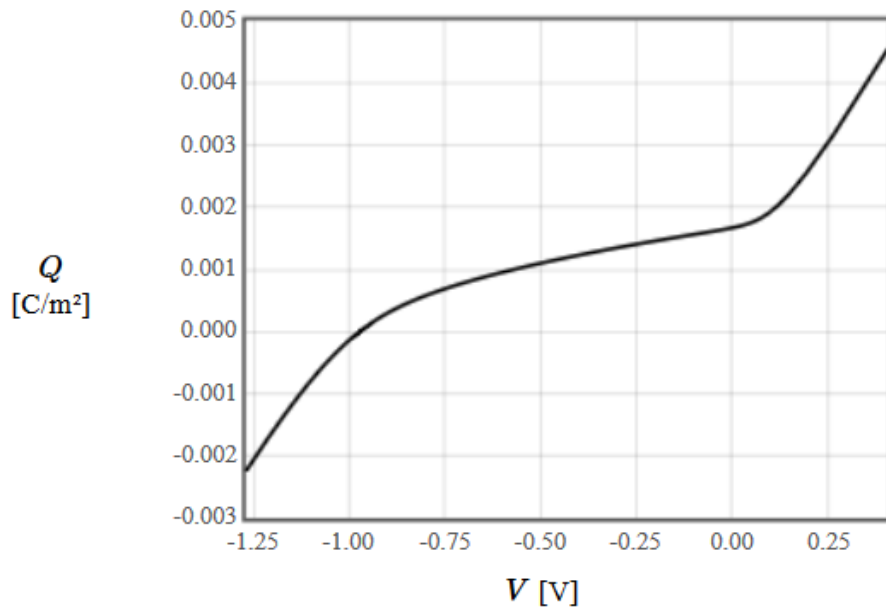


MOS Capacitor - Capacitance voltage

In capacitance-voltage profiling, the capacitance of a MOS capacitor is measured as a function of the bias voltage. The app below solves the Poisson equation to determine the charge-voltage and capacitance voltage characteristics of a MOS capacitor with a p-type substrate. This is the low-frequency result. At high frequencies, the charge at the oxide interface does not change fast enough and the characteristics take on another form.

$\phi_m =$ <input type="text" value="4.08"/> eV	$\chi_s =$ <input type="text" value="4.05"/> eV		
$t_{ox} =$ <input type="text" value="3"/> nm	$\epsilon_{ox} =$ <input type="text" value="4"/>	$N_c(300) =$ <input type="text" value="2.78E19"/> 1/cm ³	$T =$ <input type="text" value="300"/> K
$E_g =$ <input type="text" value="1.166-4.73E-4*T*T/(T+636)"/> eV	$\epsilon_{semi} =$ <input type="text" value="12"/>	$N_v(300) =$ <input type="text" value="9.84E18"/> 1/cm ³	$N_A =$ <input type="text" value="1E17"/> 1/cm ³
<input type="button" value="Submit"/>	<input type="button" value="Si"/>	<input type="button" value="Ge"/>	<input type="button" value="GaAs"/>

Q - V



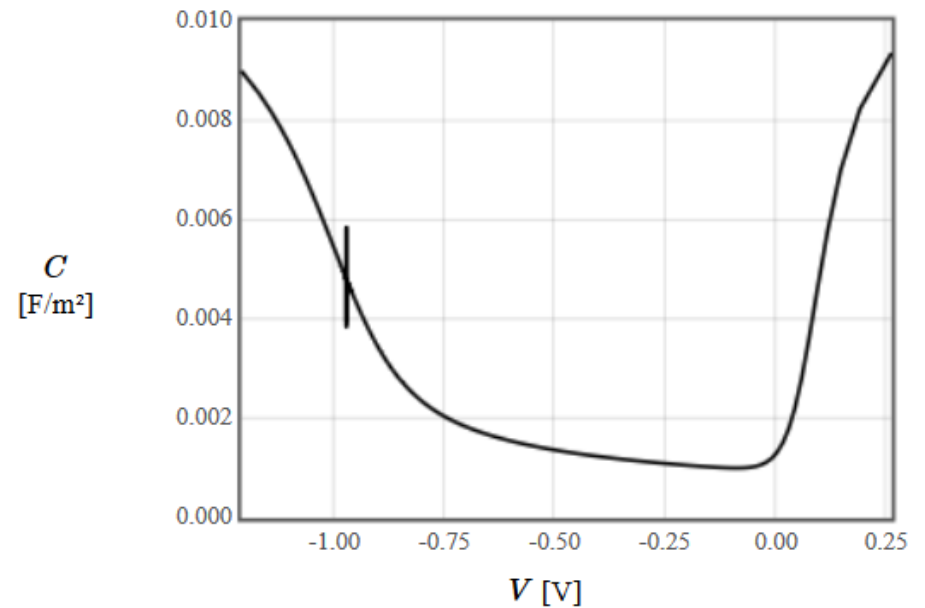
$$E_g = 1.12 \text{ eV}$$

$$C_{ox} = \frac{\epsilon_{ox}}{t_{ox}} = 0.0118 \text{ F/m}^2$$

$$n_i = 6.40e9 \text{ 1/cm}^3$$

$$V_T = 0.0292 \text{ V}$$

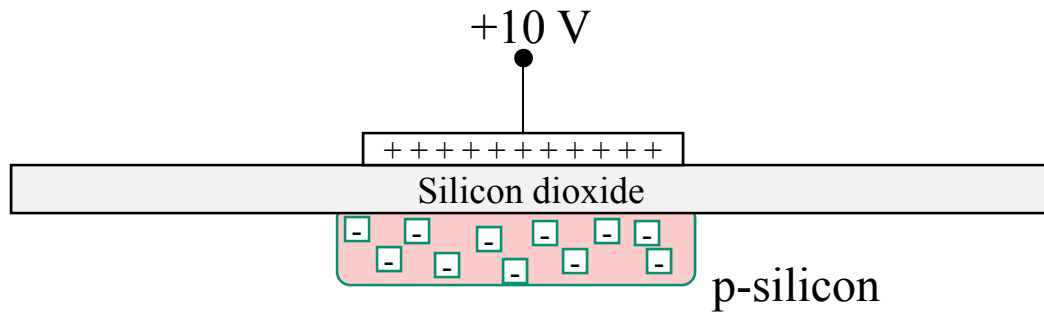
C - V



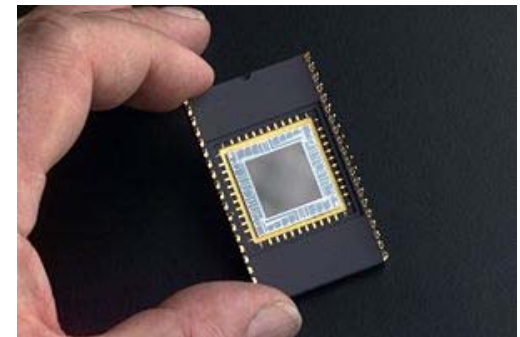
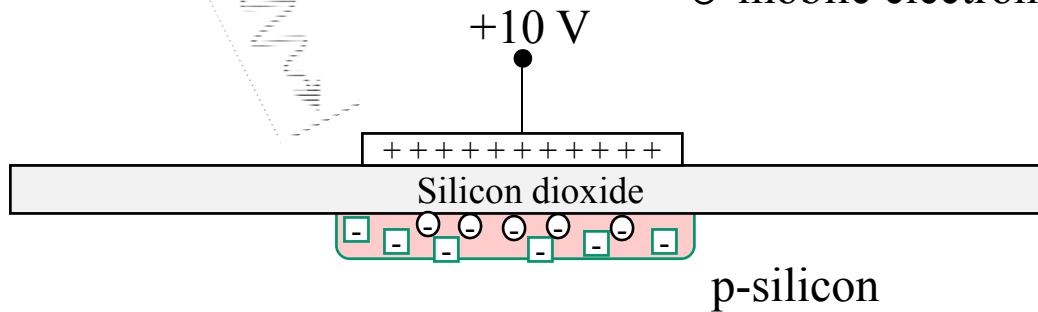
$$\phi_s = 5.05 \text{ eV}$$

$$V_{fb} = \phi_m - \phi_s = -0.972 \text{ V}$$

CCD devices



- fixed acceptors
- ⊖ mobile electrons



CCD devices

